

Measurement of the radiation hardness of the Philips dSiPMs

PANDA collaboration meeting

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Objectives

Measurement setup

Measurement results

Final discussion

Objectives

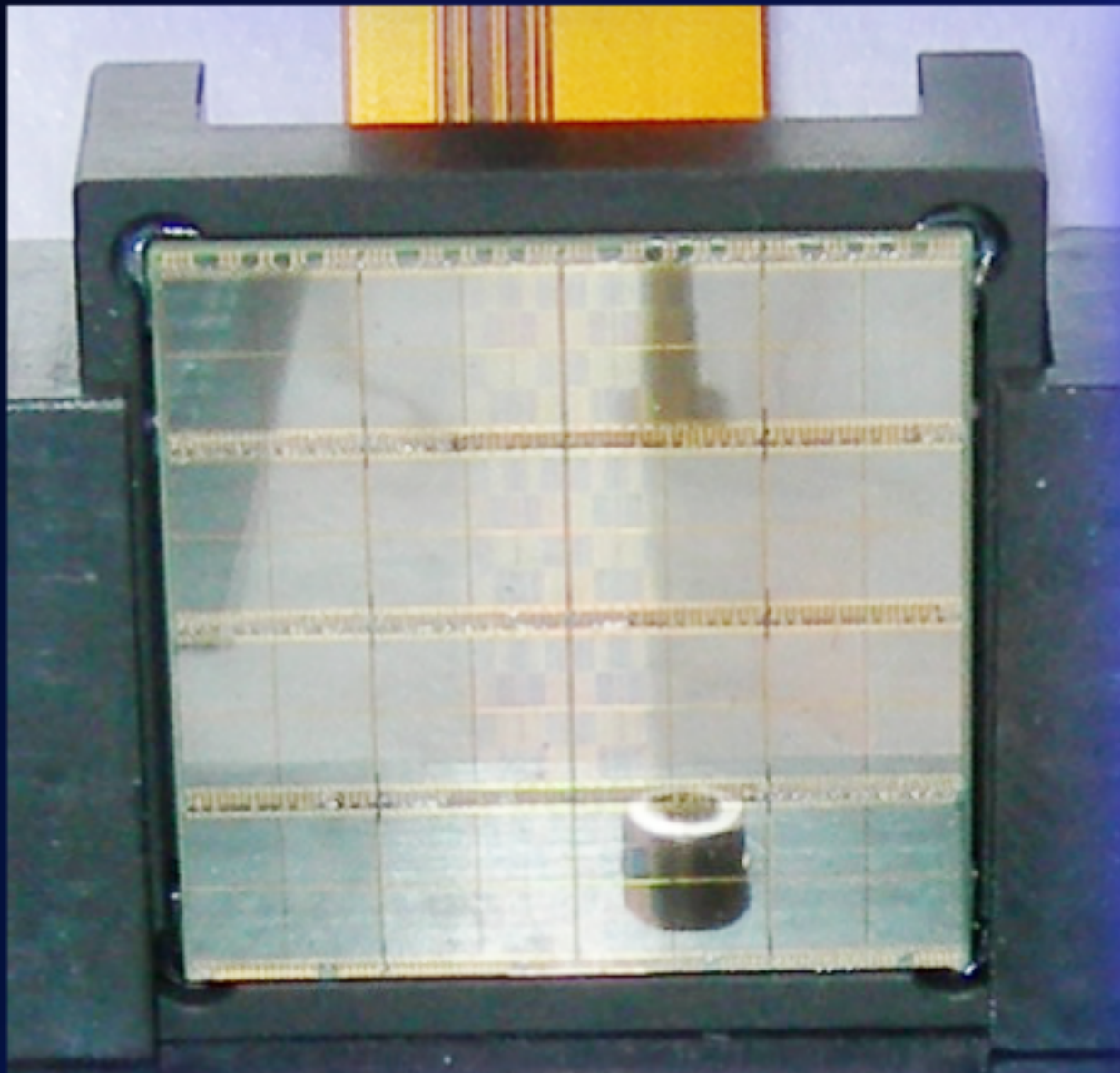


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Schedule / radiant exposure



- ▷ TEK module, 25600 cells: exposition in steps until total destruction
- ▷ TEK module, 12800 cells: exposition in steps until total destruction
- ▷ two TEK modules, 12800 cells: lesser dose to study self healing

Bonn:

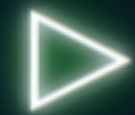
- ▷ protons
- ▷ 14 MeV

Disc DIRC:

- ▷ expected fluence for the sensors in 1 MeV neutron equivalent: $\approx 10^{12}$ per square centimeter
- ▷ fluence in 14 MeV proton equivalent is 3.7 times less

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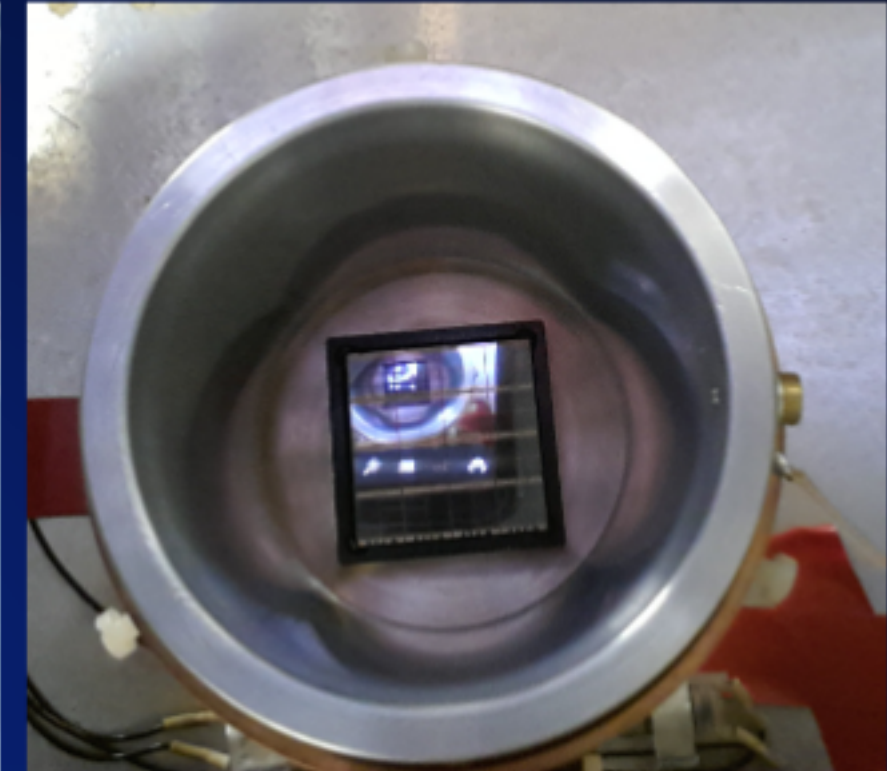
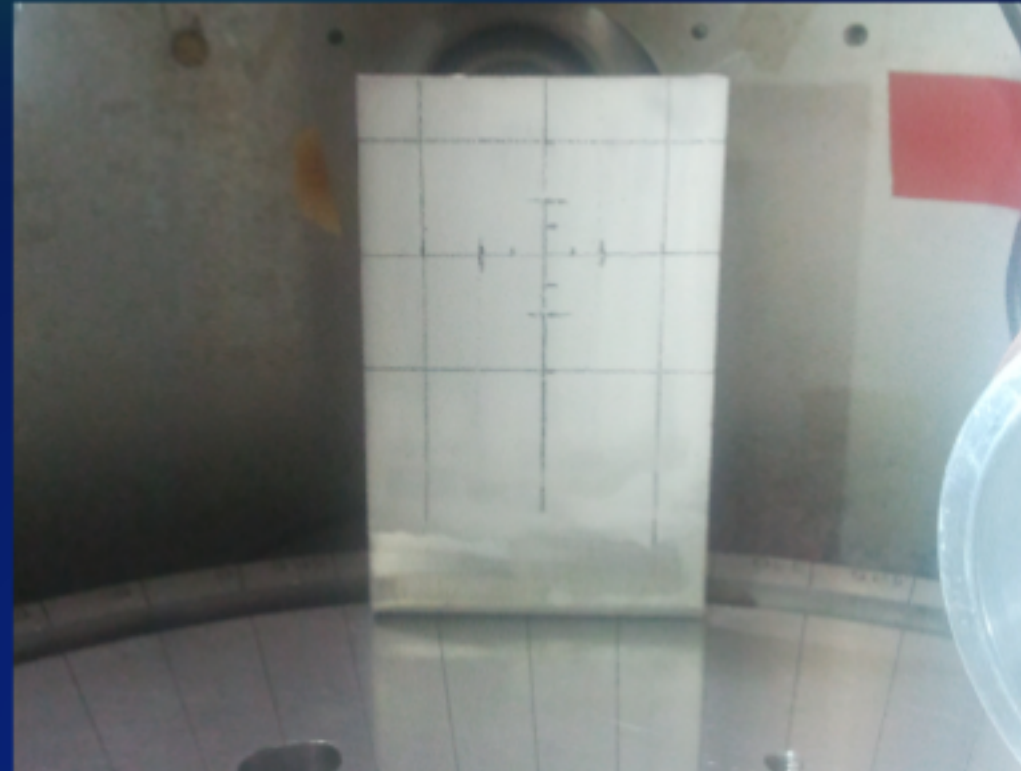
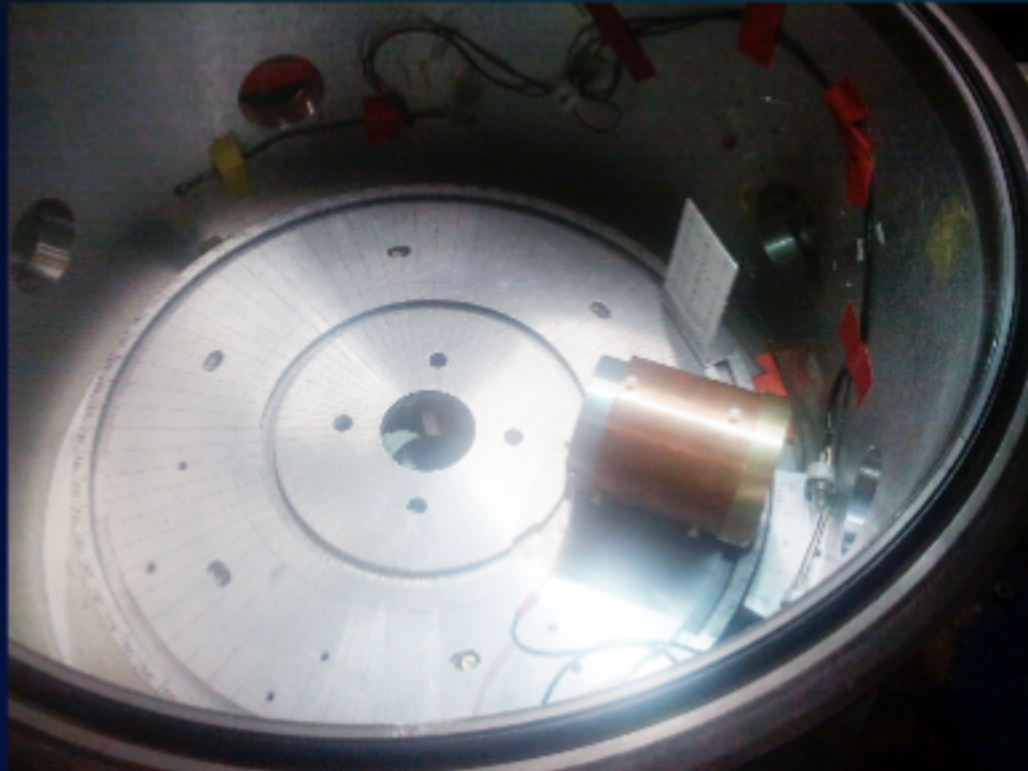
Measurement setup



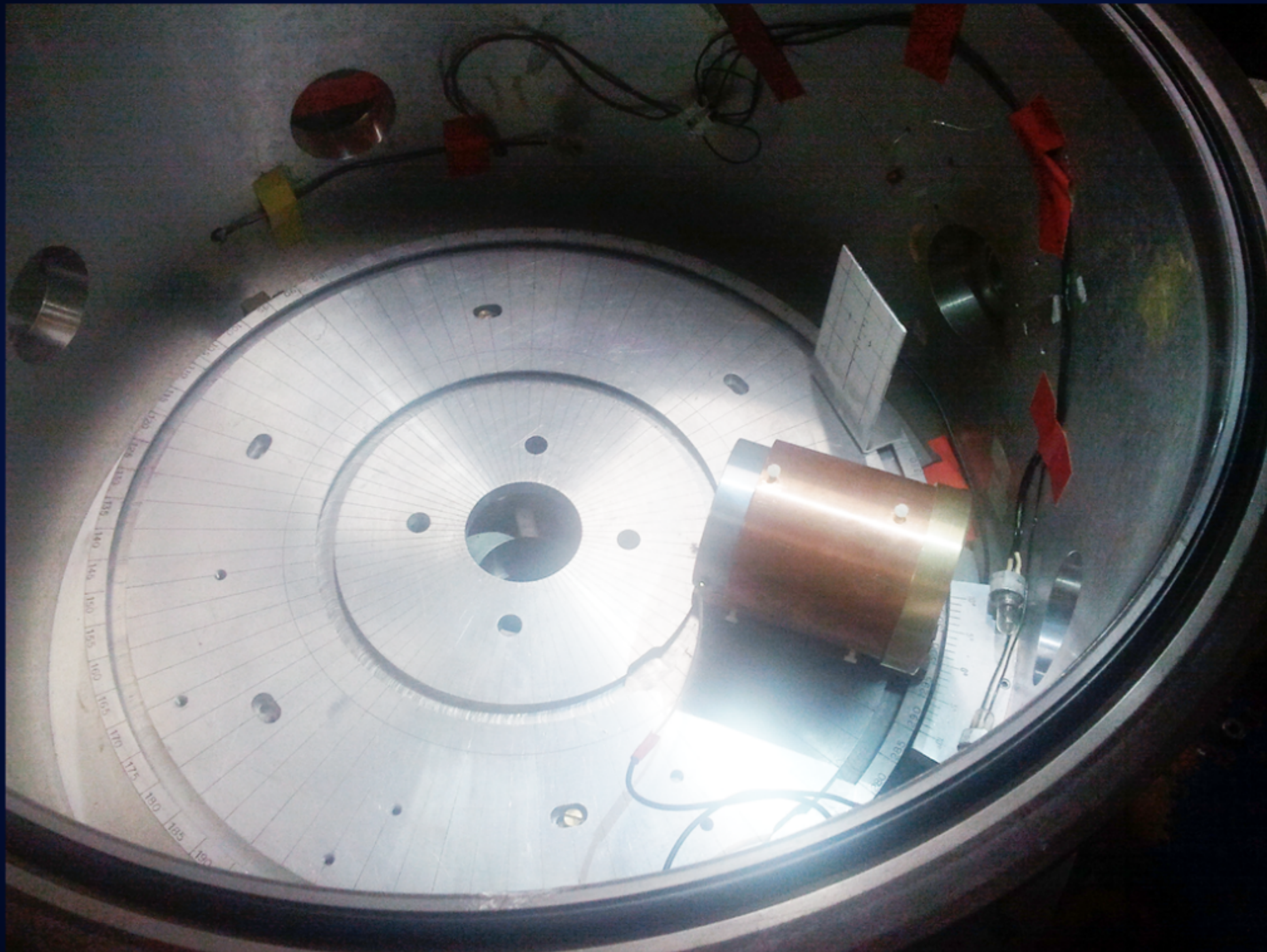
Measurement results

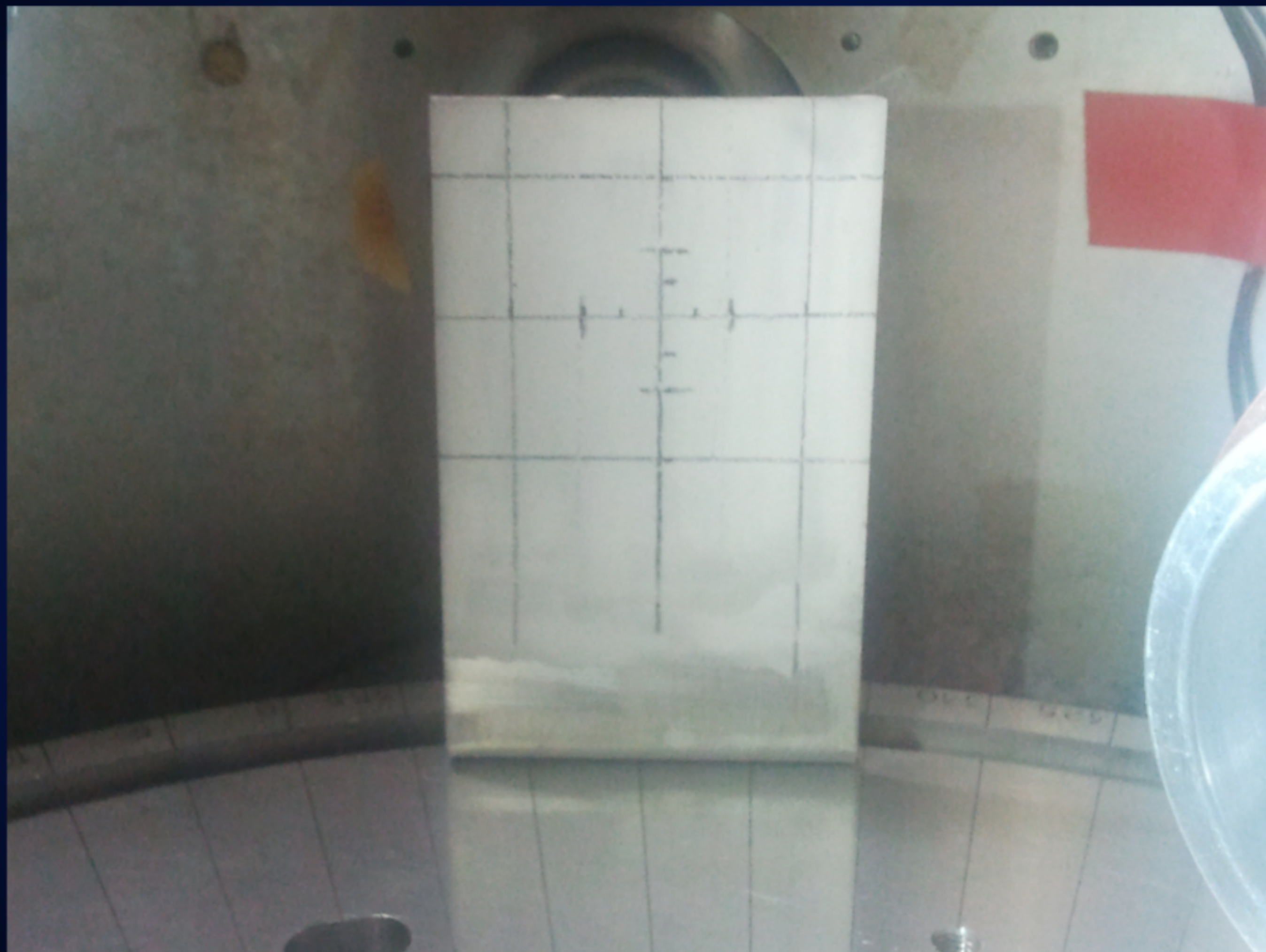
Final discussion

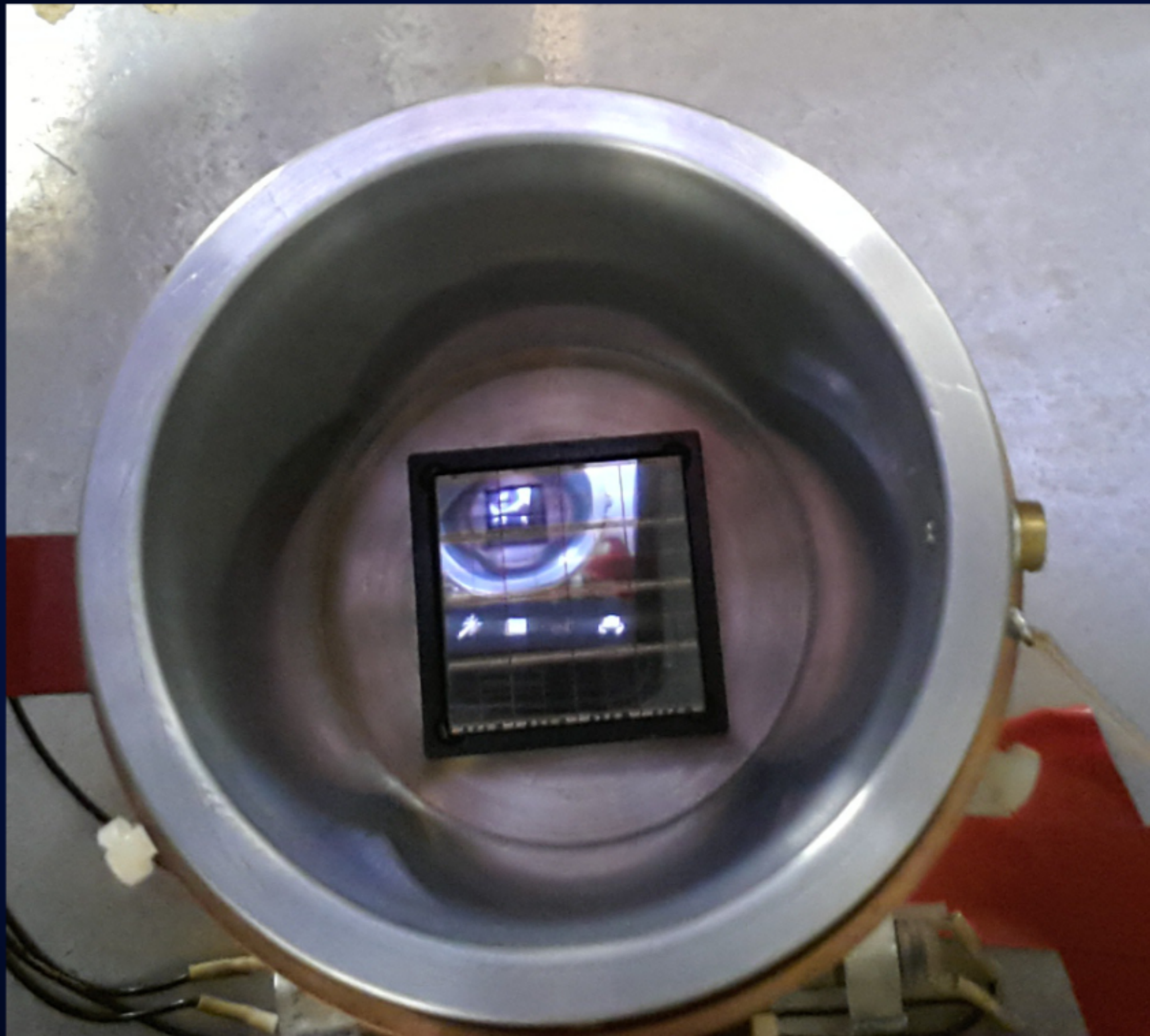
Scattering chamber



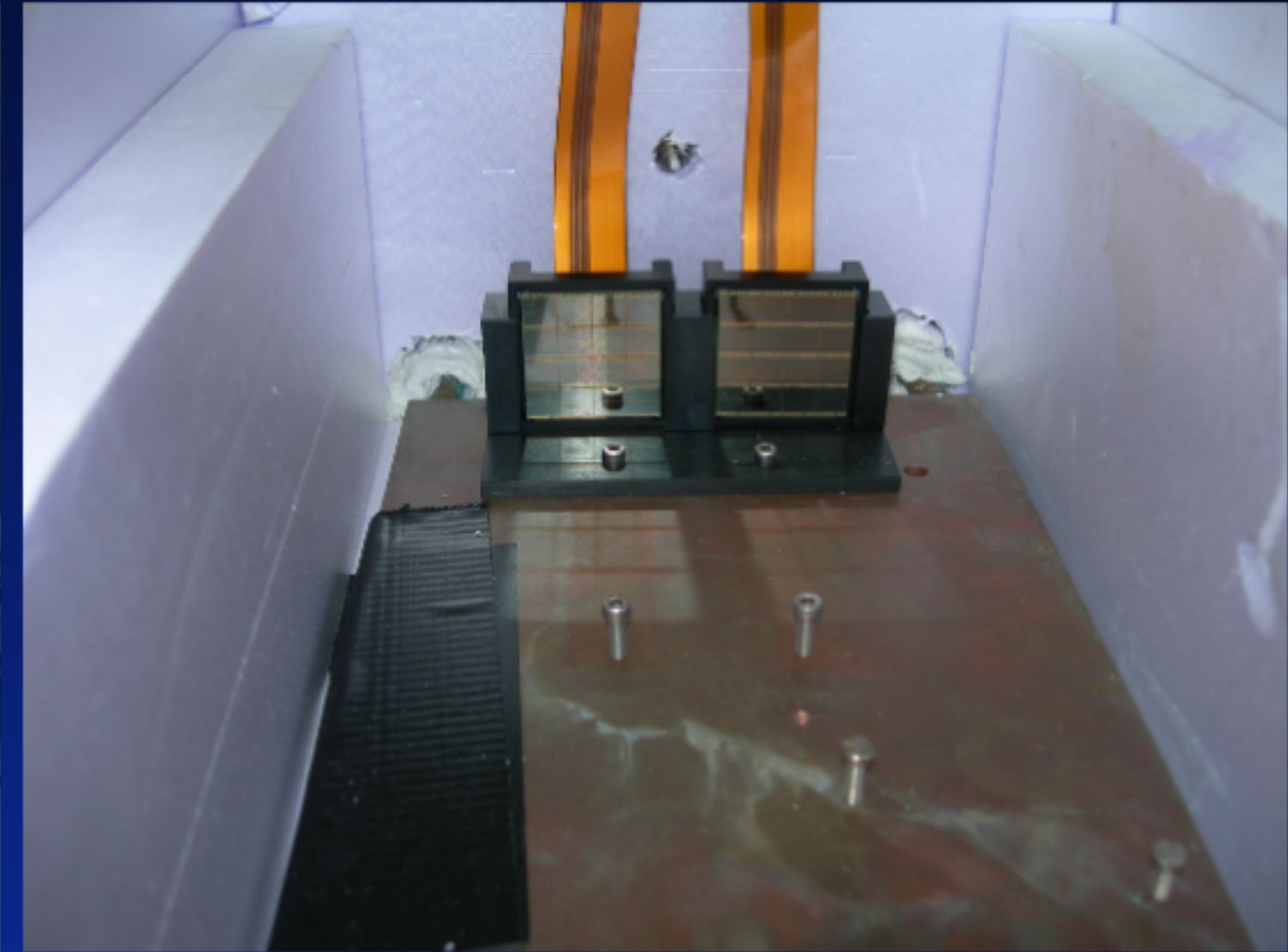
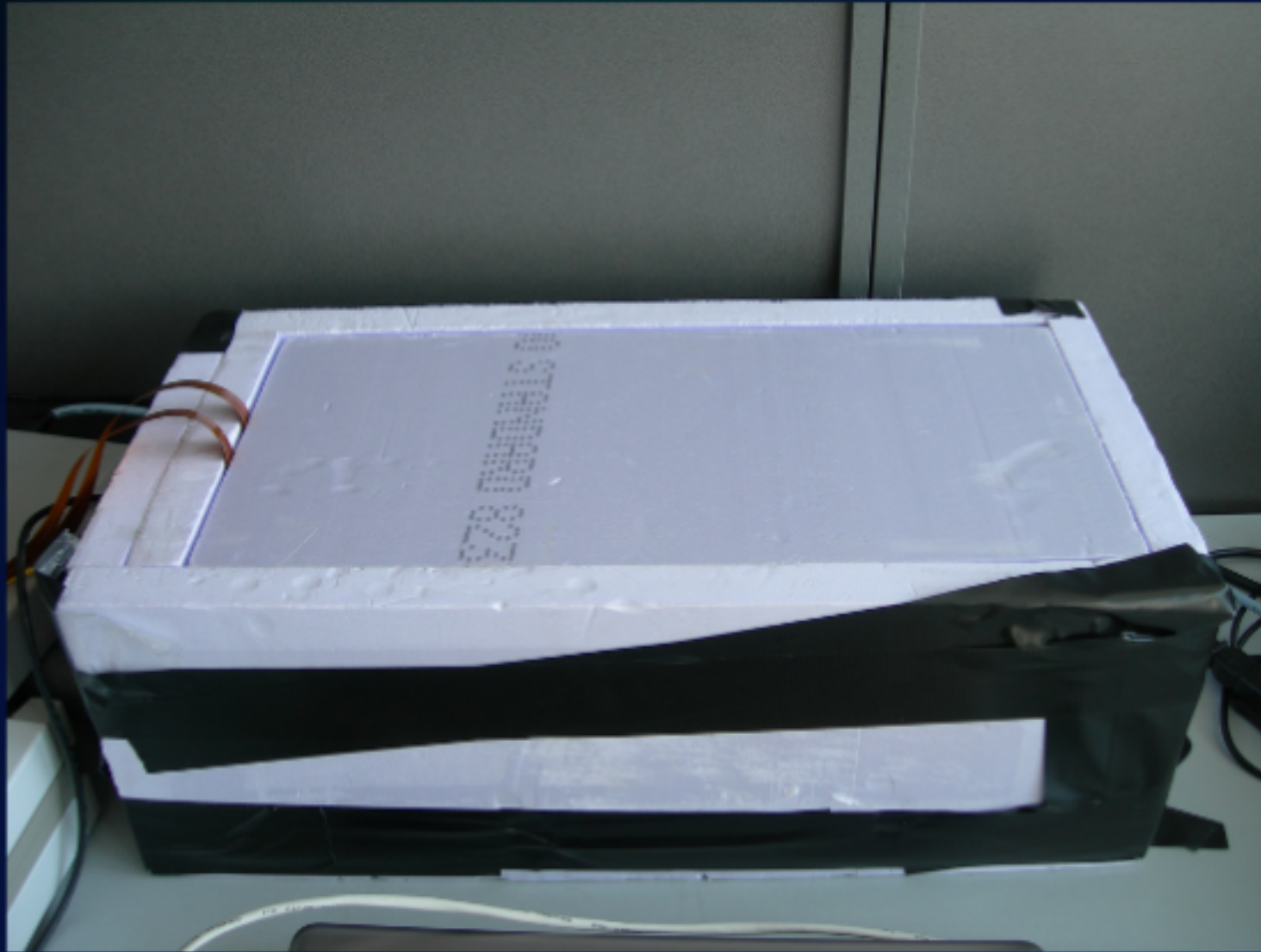
- ▷ vacuum: 10^{-5} millibar
- ▷ proton beam defocussed to illuminate quadratic area
- ▷ fluorescence monitor to check homogeneous illumination
- ▷ beam could be wobbled as well to irradiate sensor line by line, might illuminate more uniformly, but was not used here



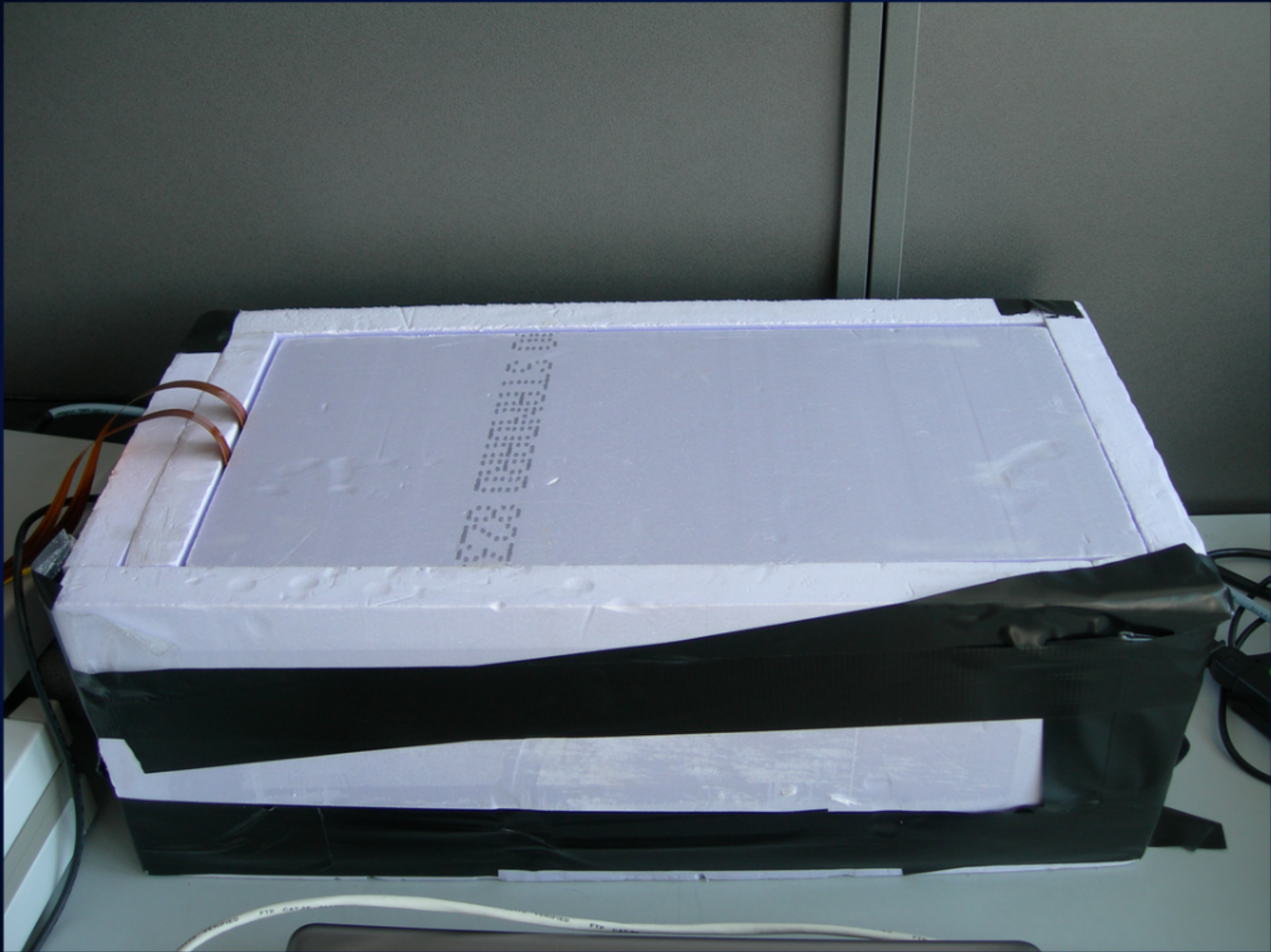


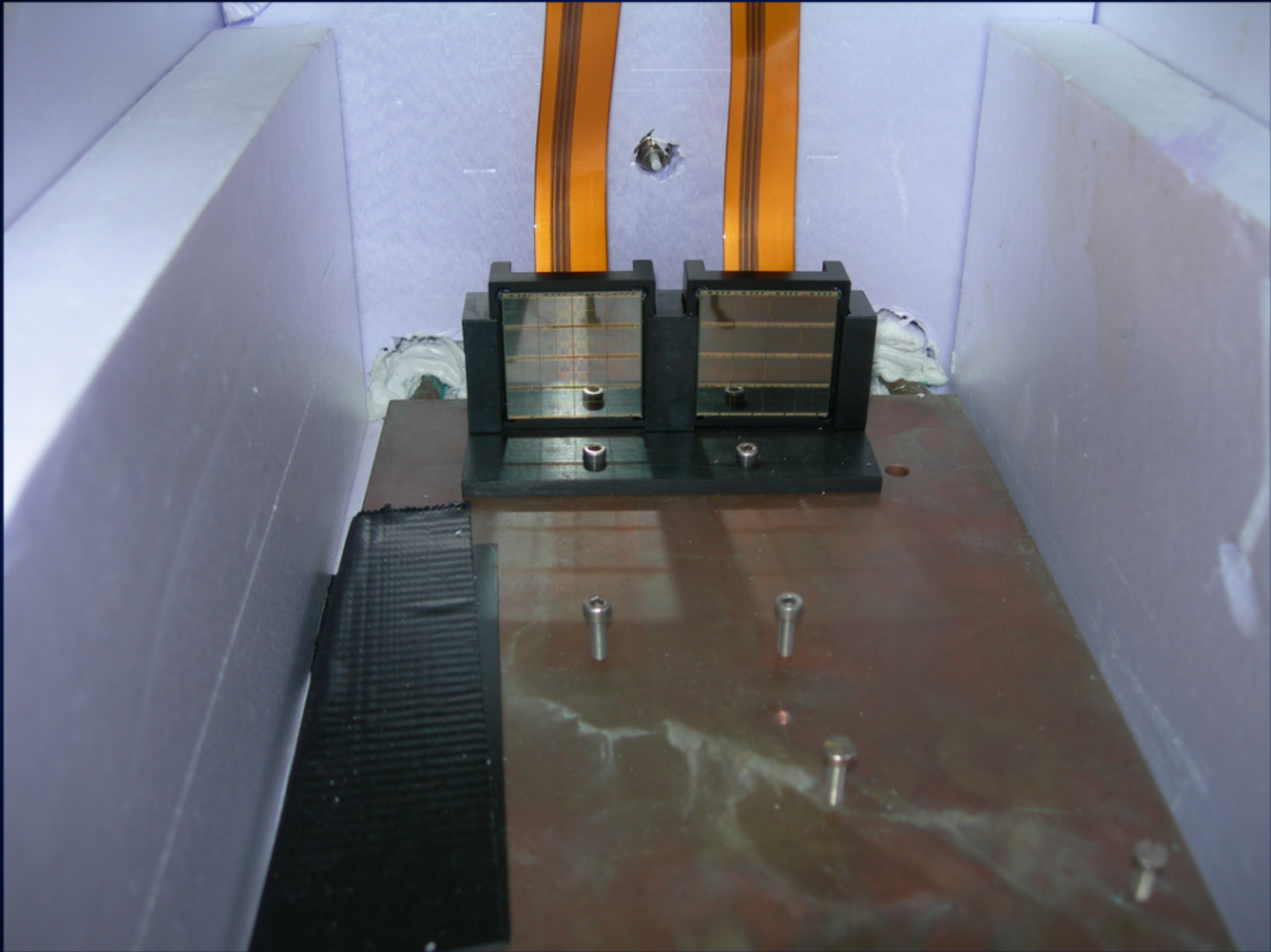


Cooling box



- ▷ irradiated sensor and identically constructed reference sensor mounted on copper plate which was soldered on a cooling coil
- ▷ cooling liquid temperatures of -10°C and 20°C
- ▷ dark count rate measurements and measurements with pulsed laser (1 MHz, 400 nm)
- ▷ hole for laser glass fiber above the sensors, no direct light, but diffusely reflected from opposite inner surface of the box

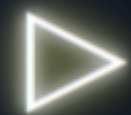




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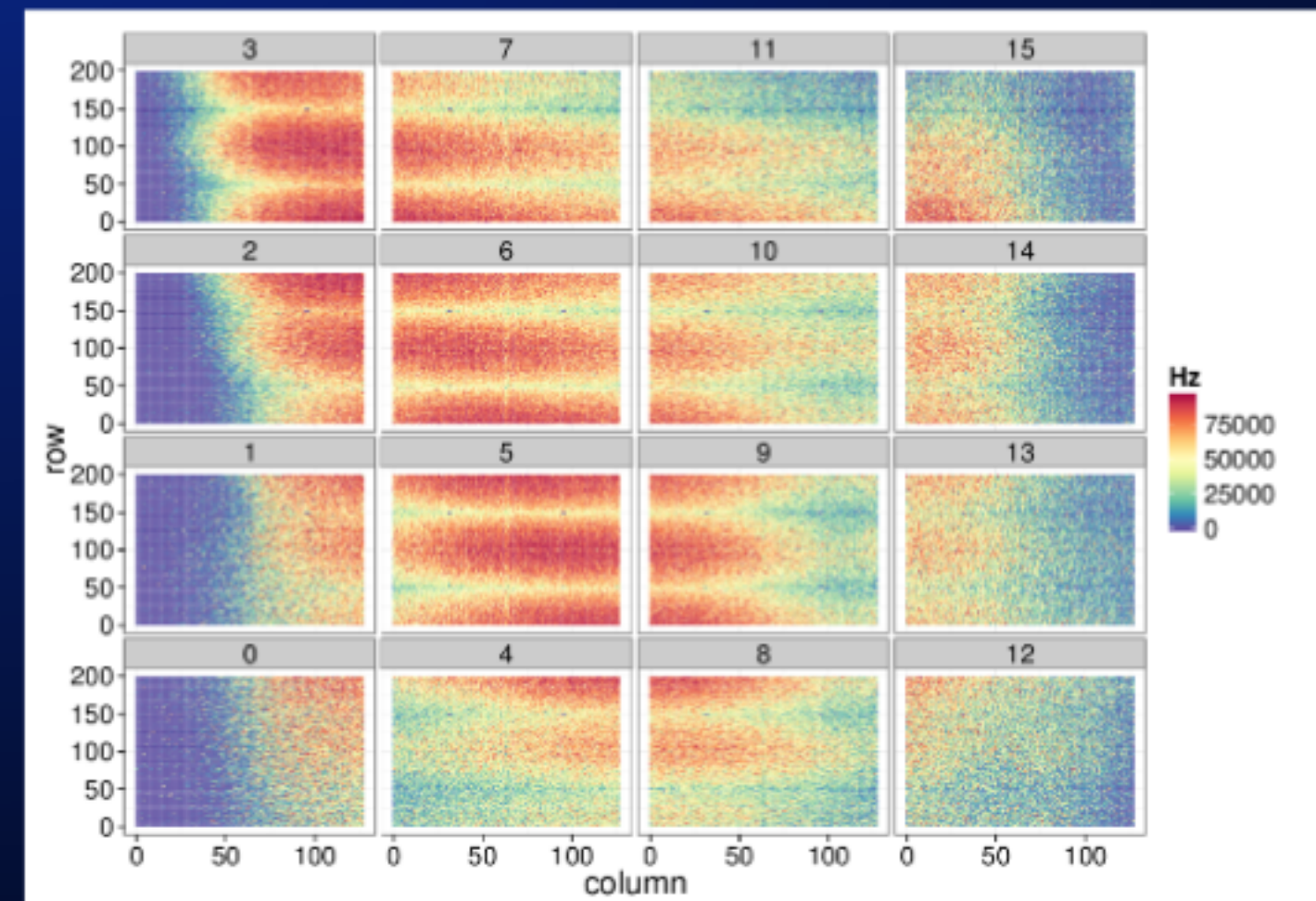
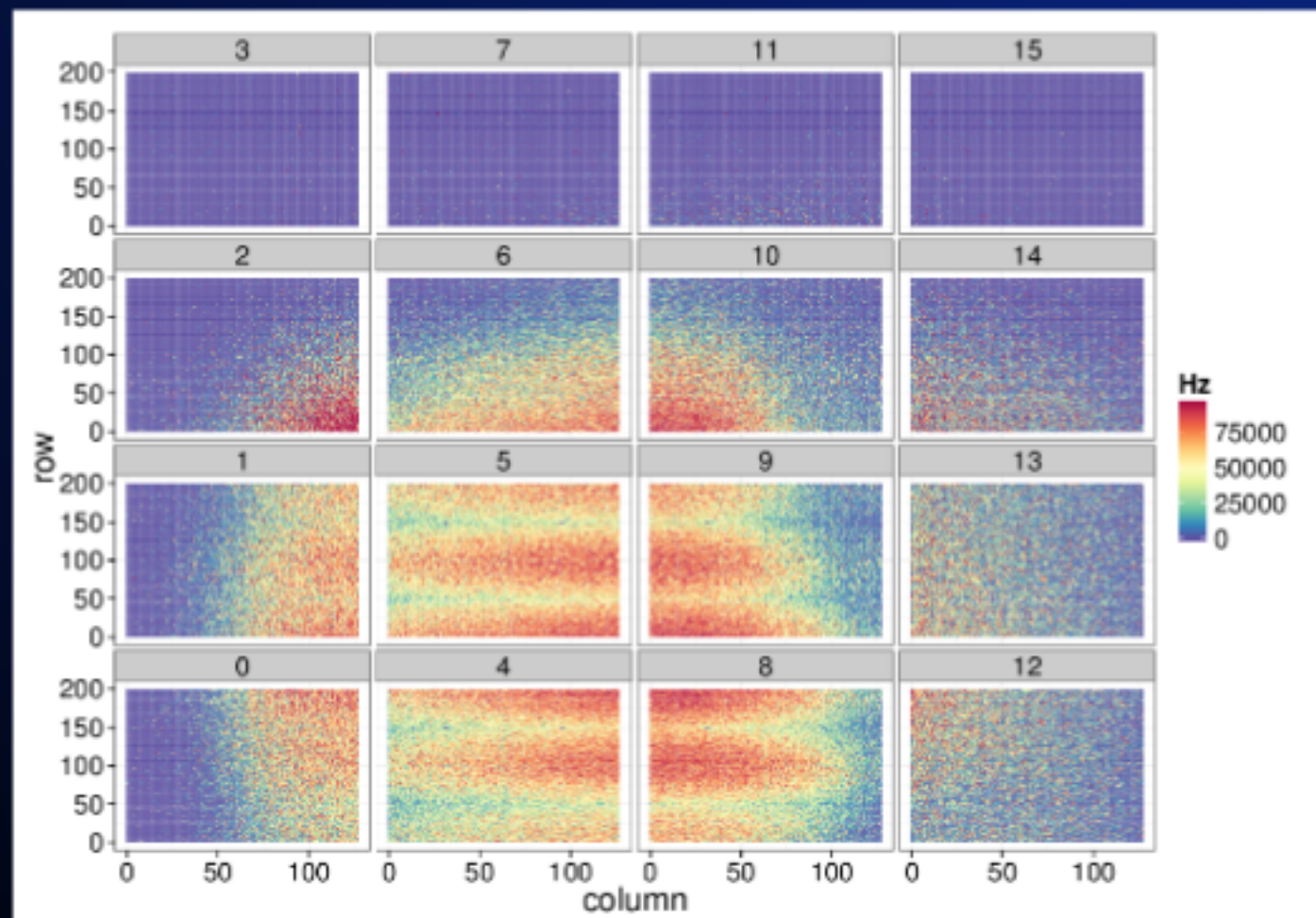
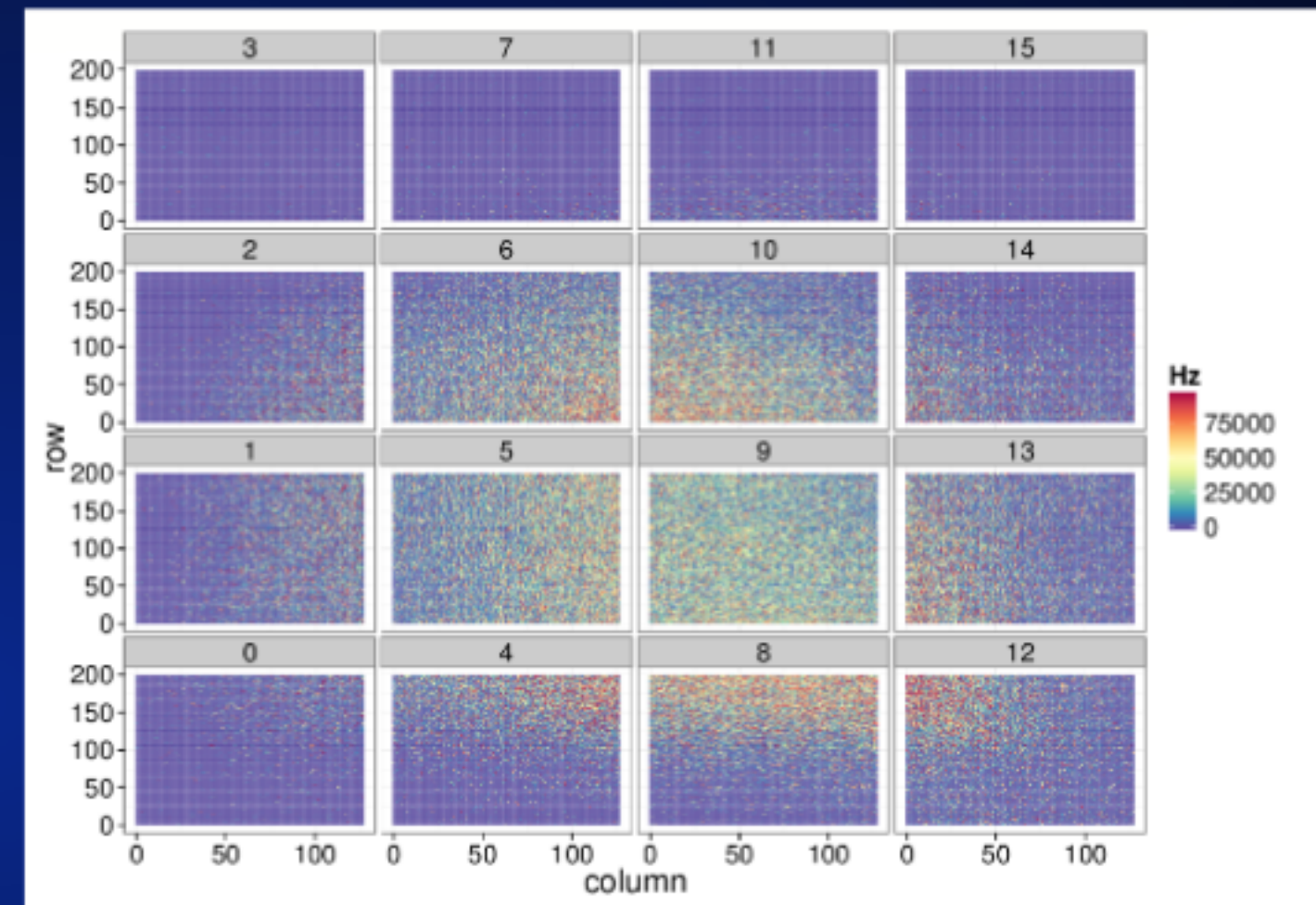
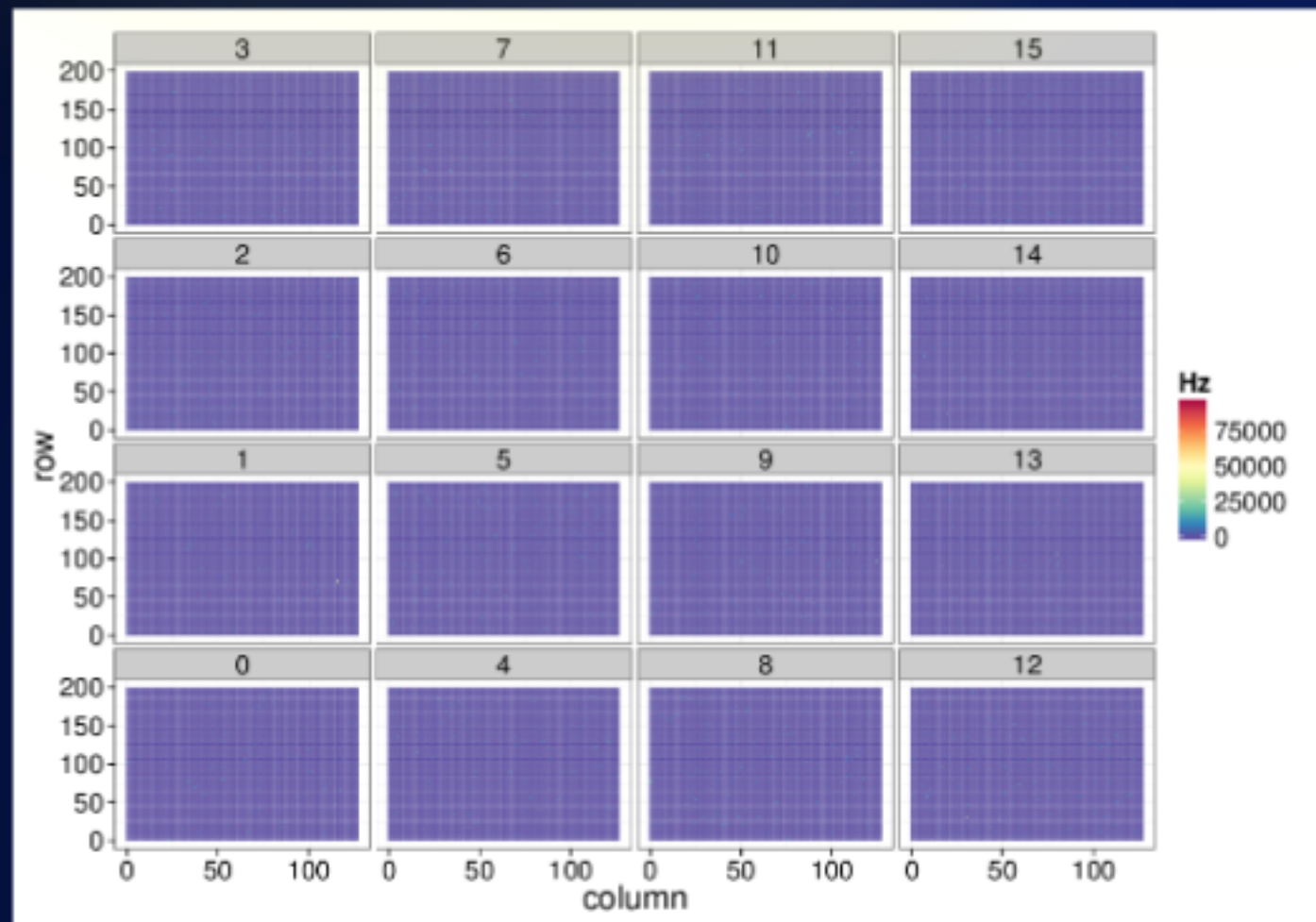
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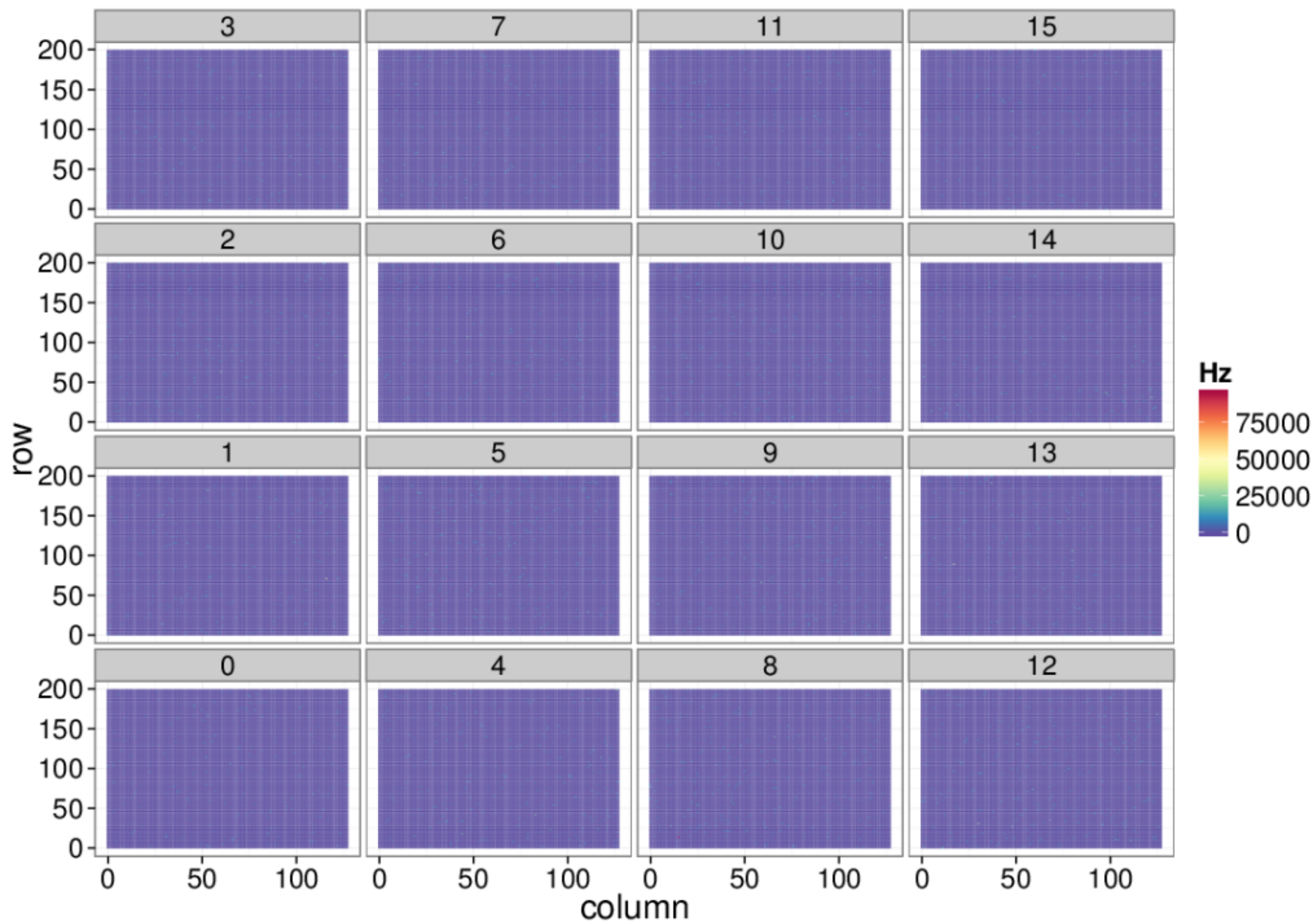
Measurement results

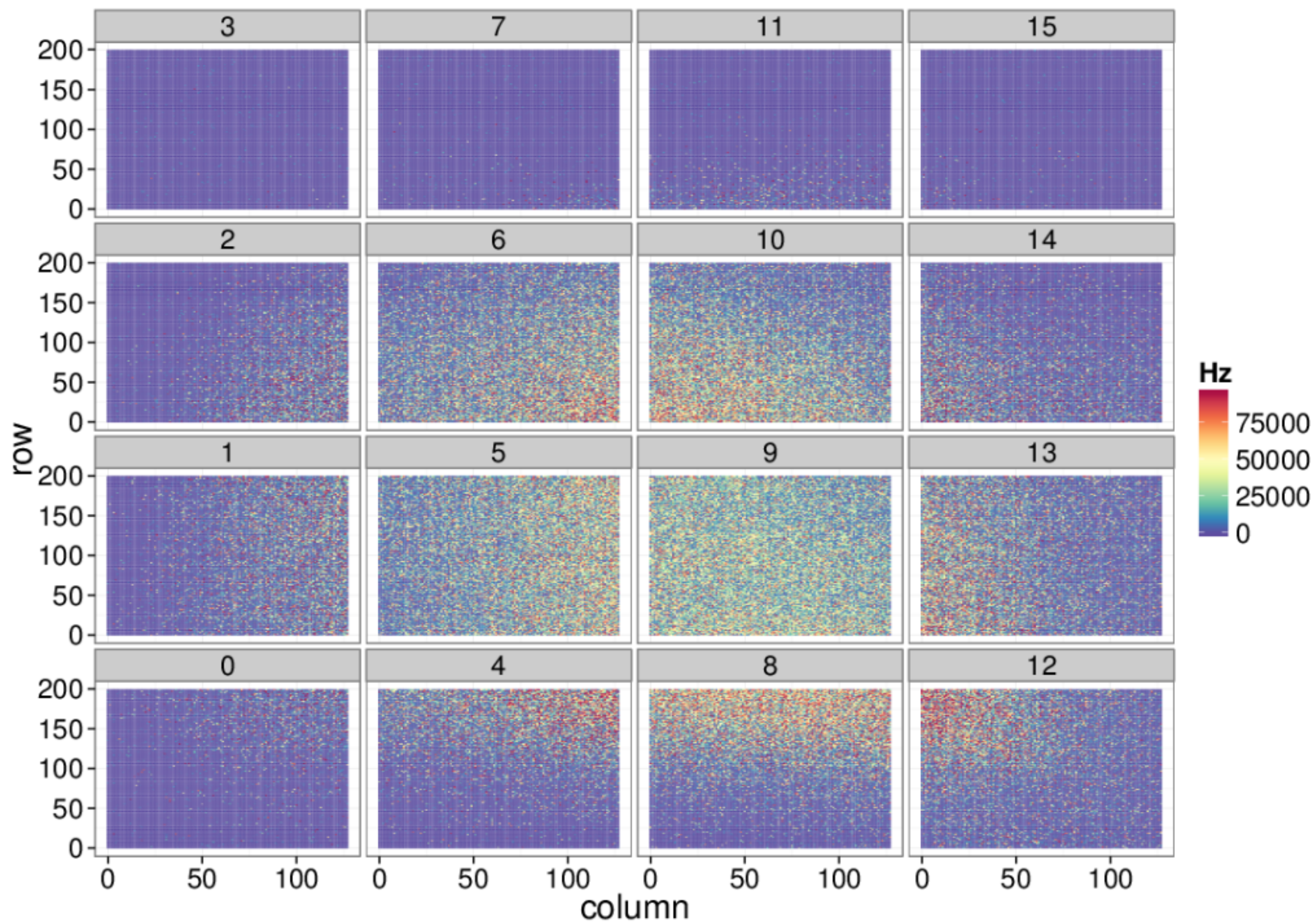


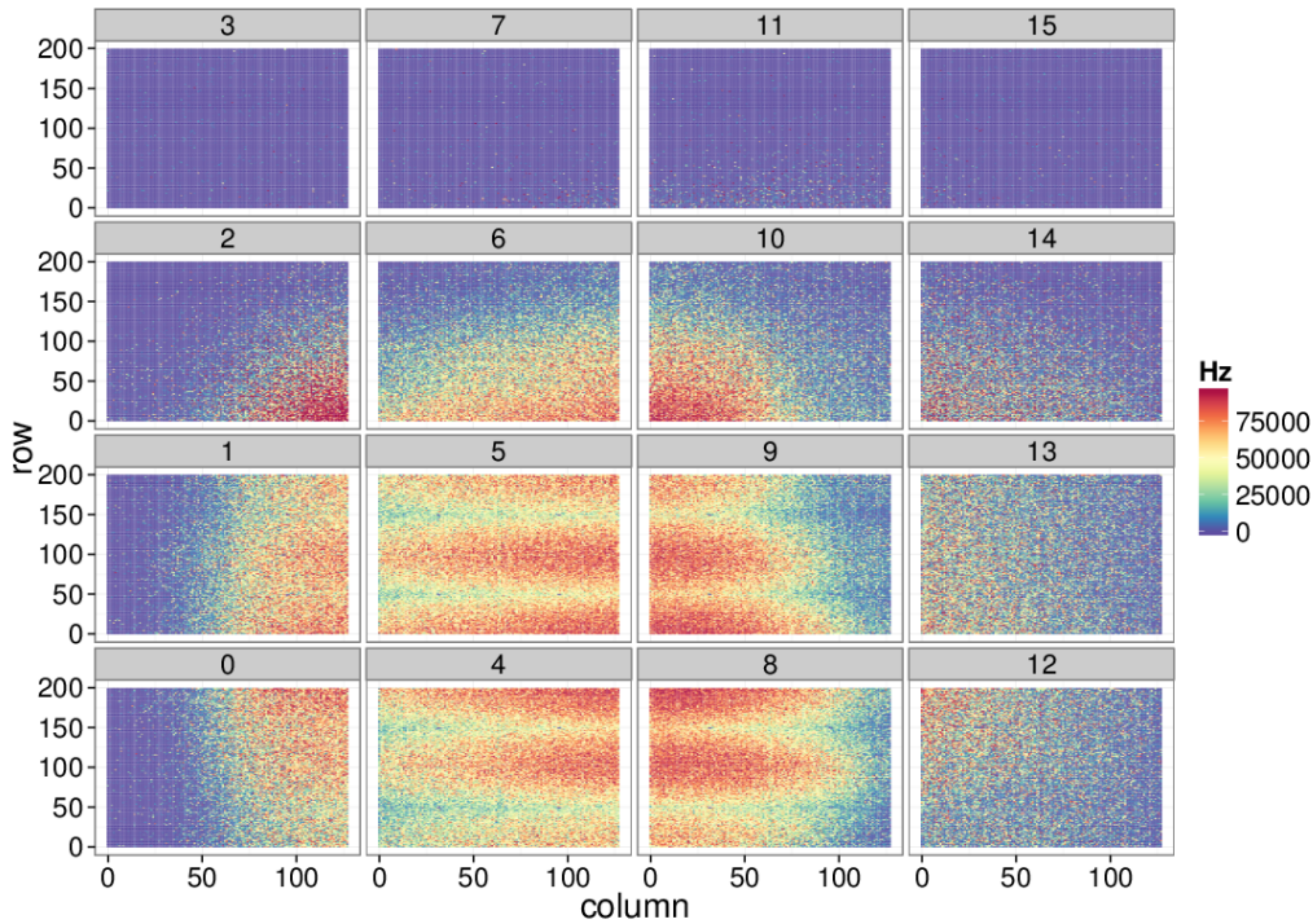
Final discussion

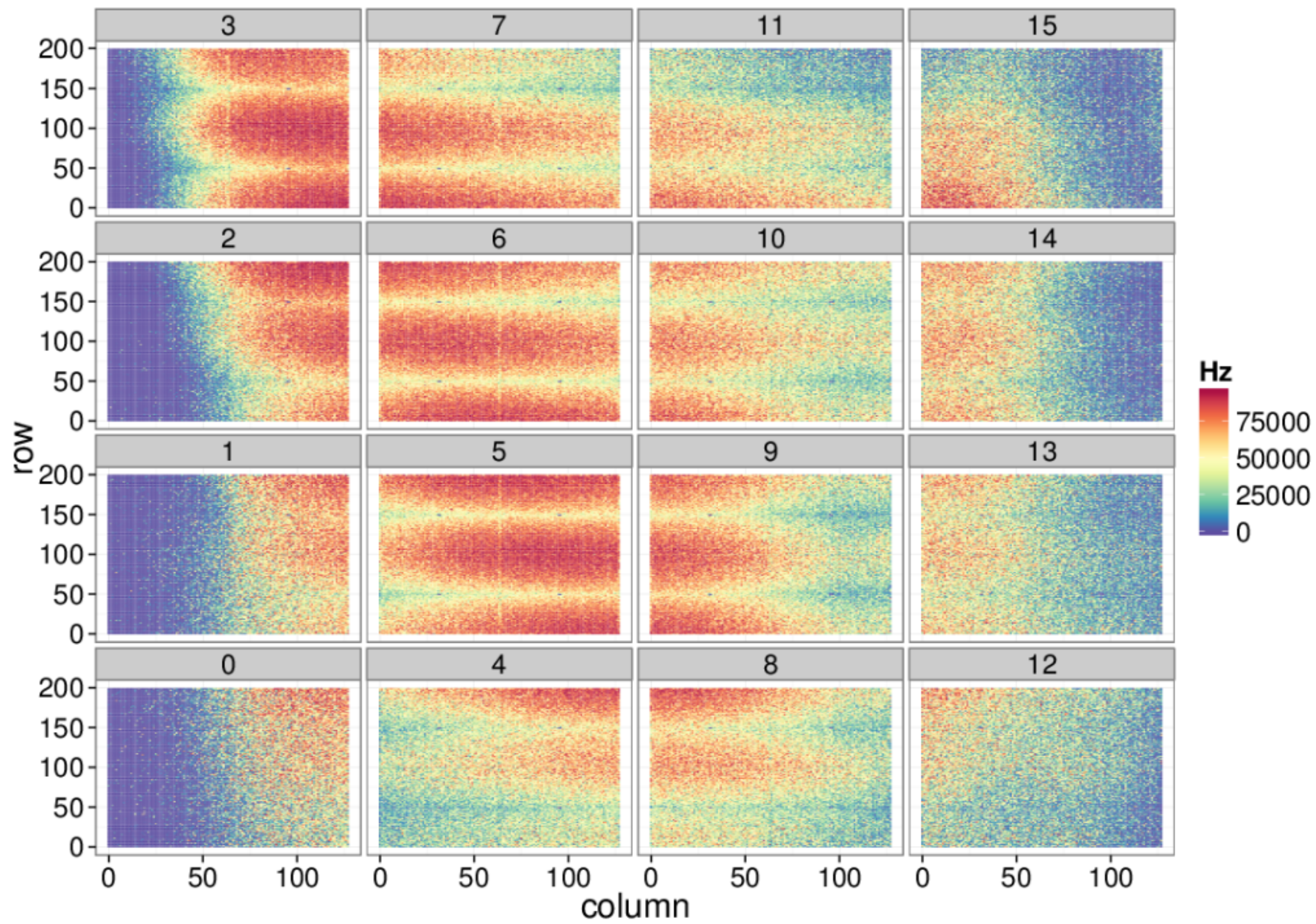
Dark count maps for the irradiated TEK modules



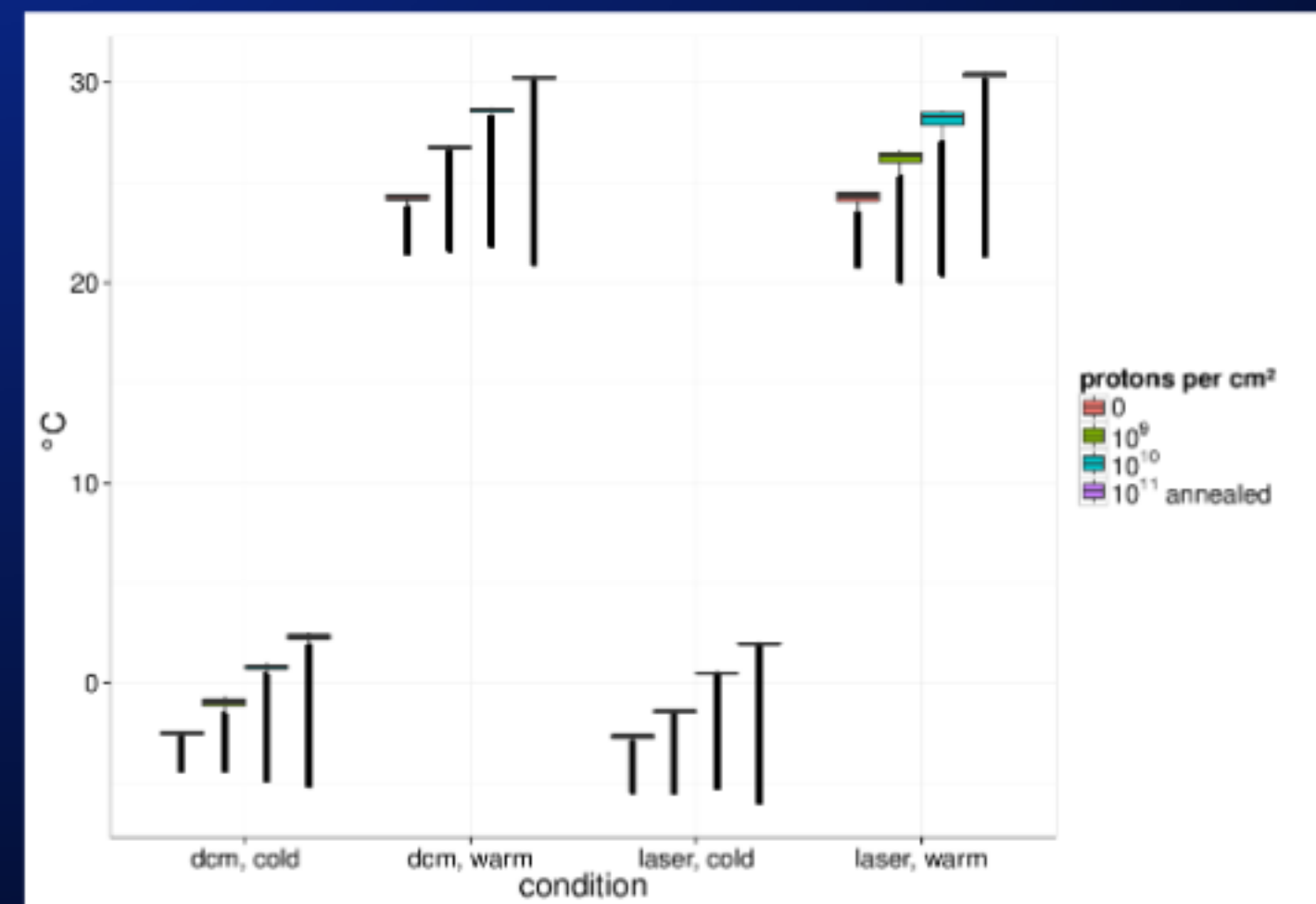
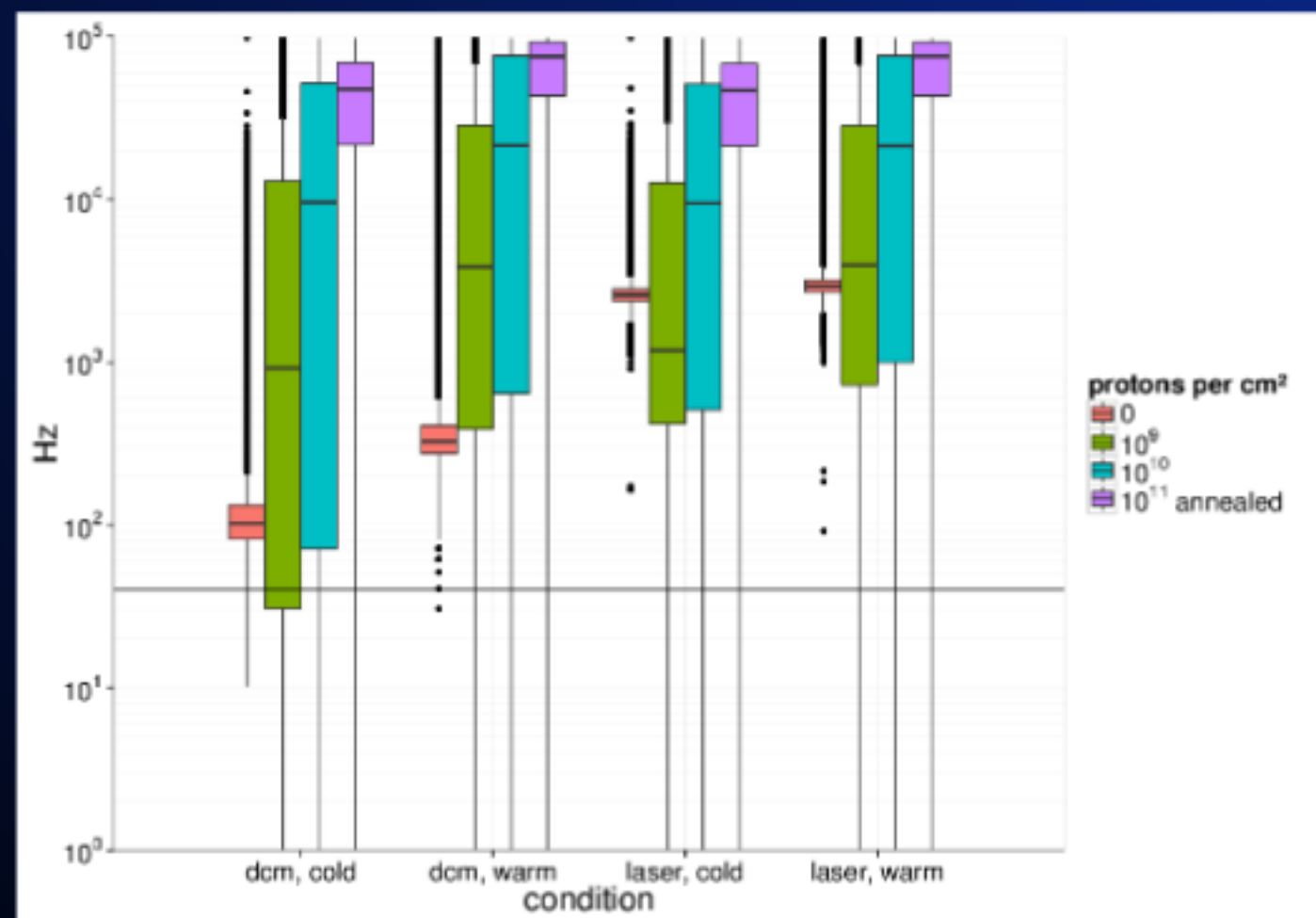
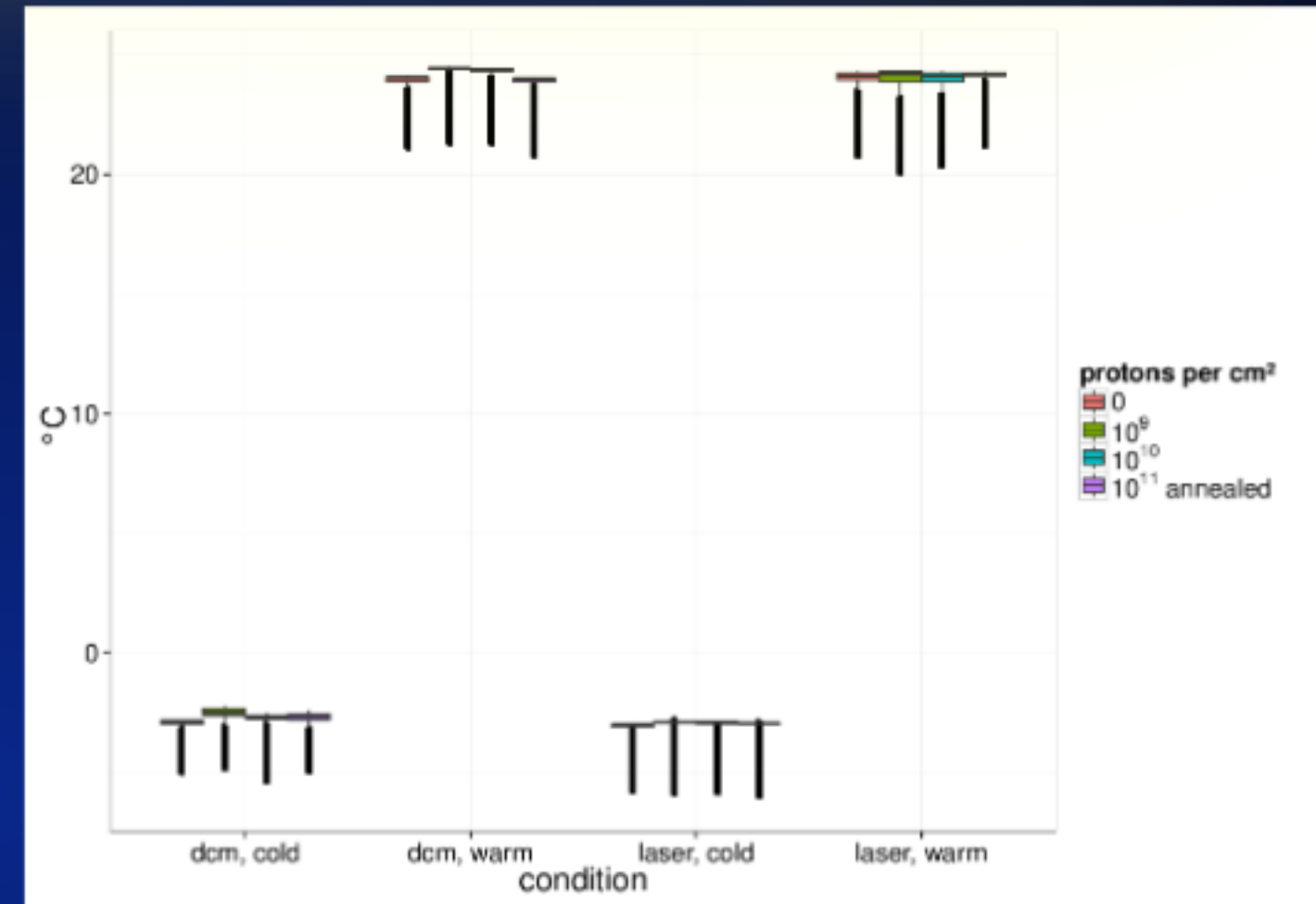
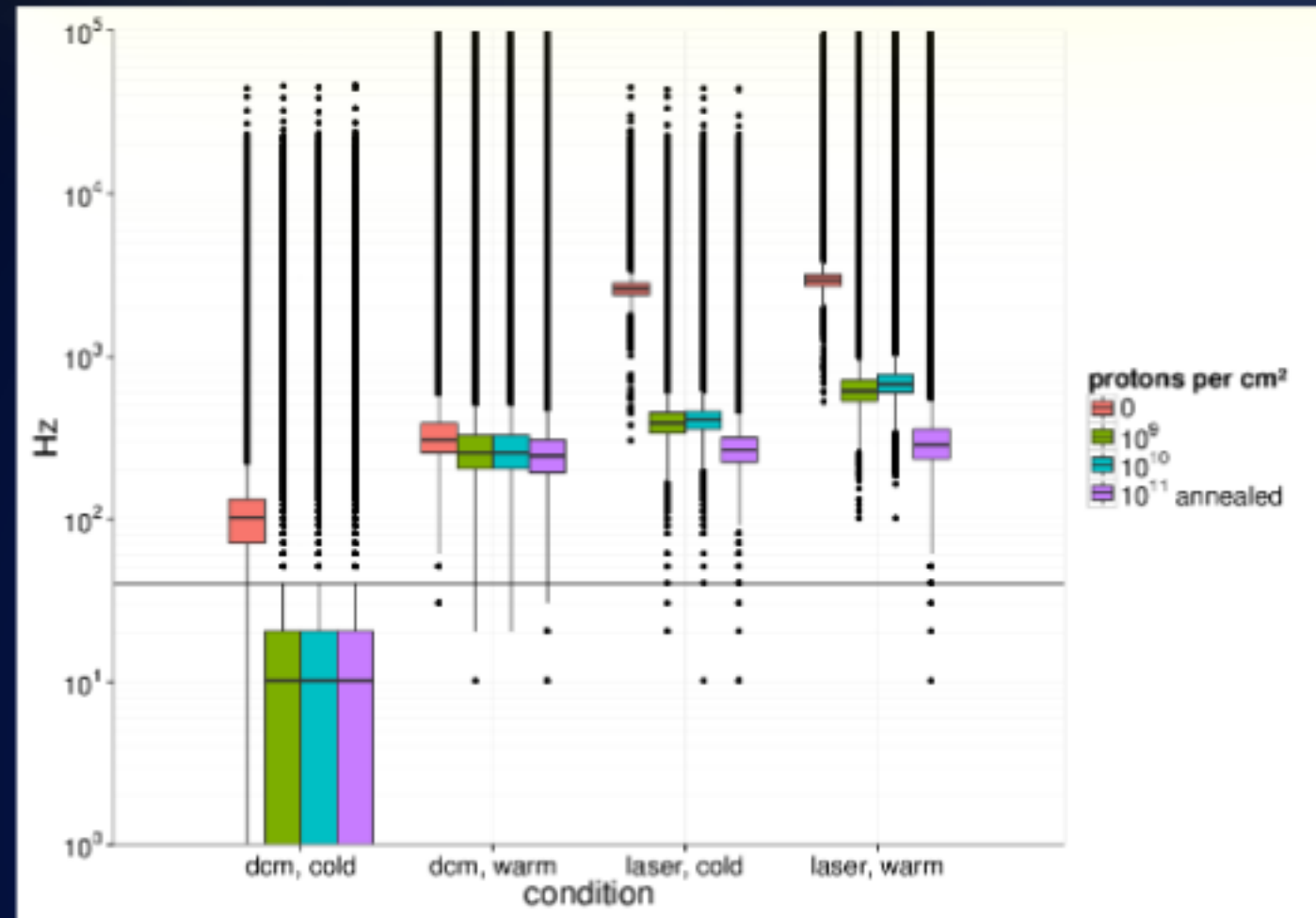


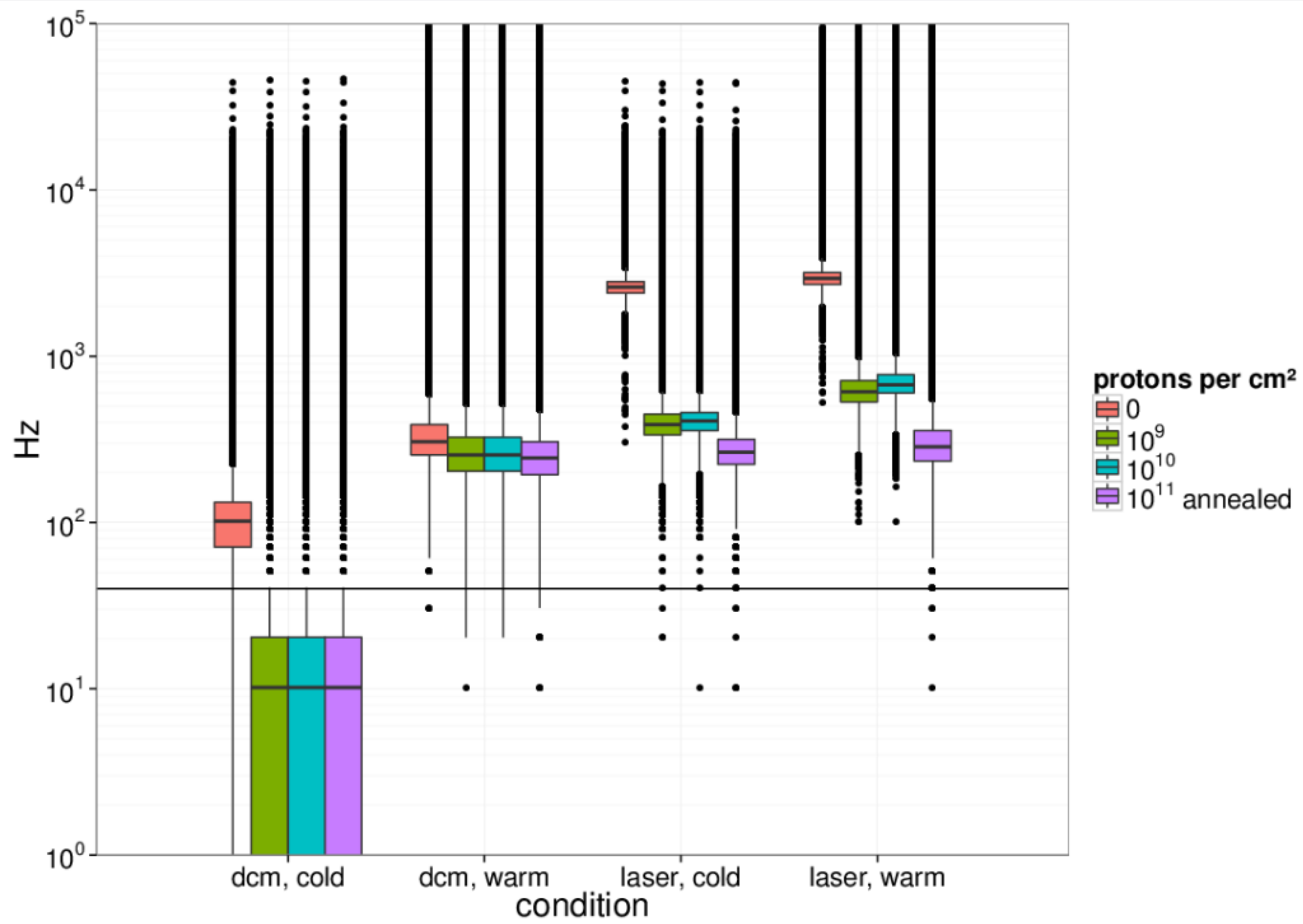


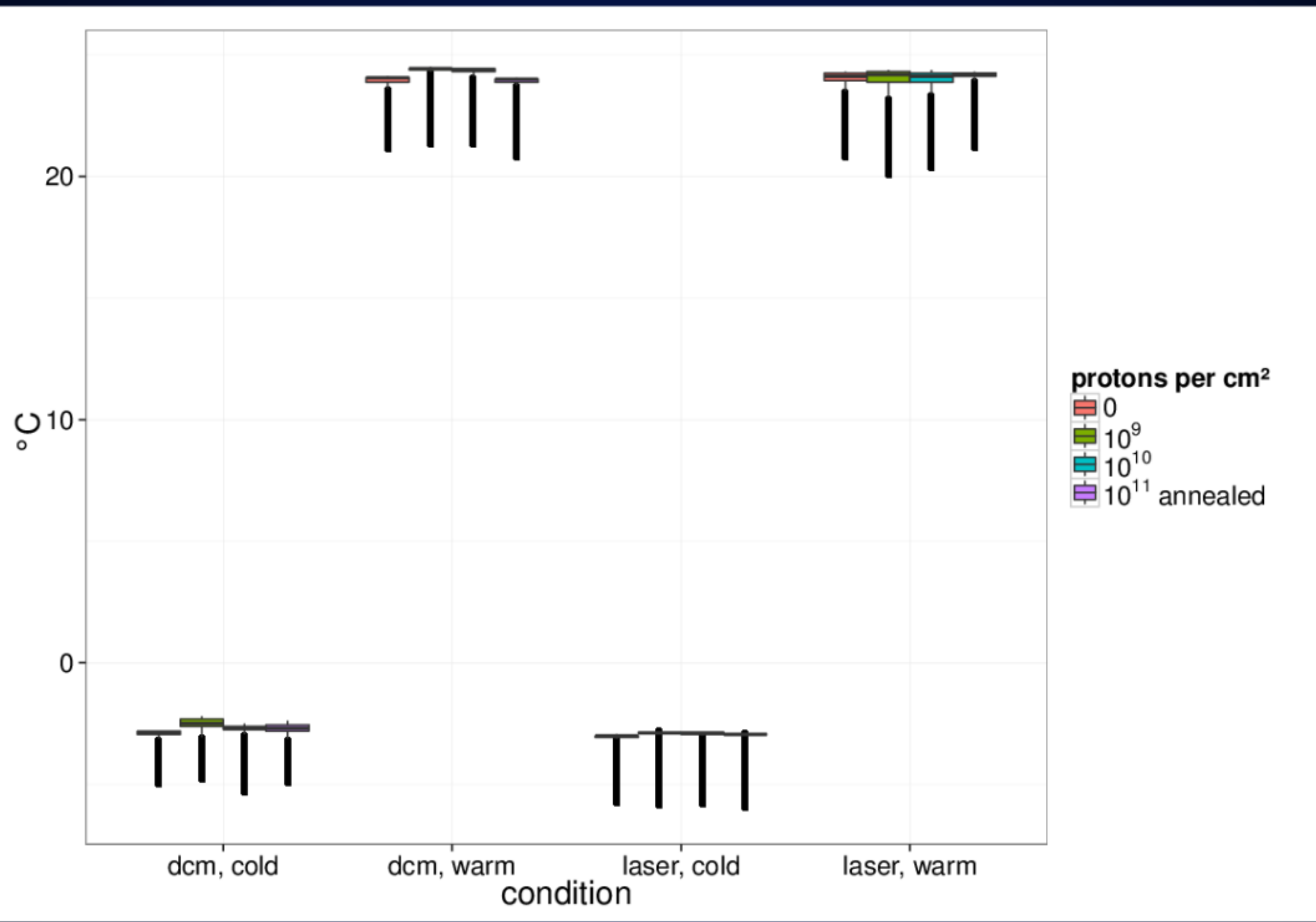


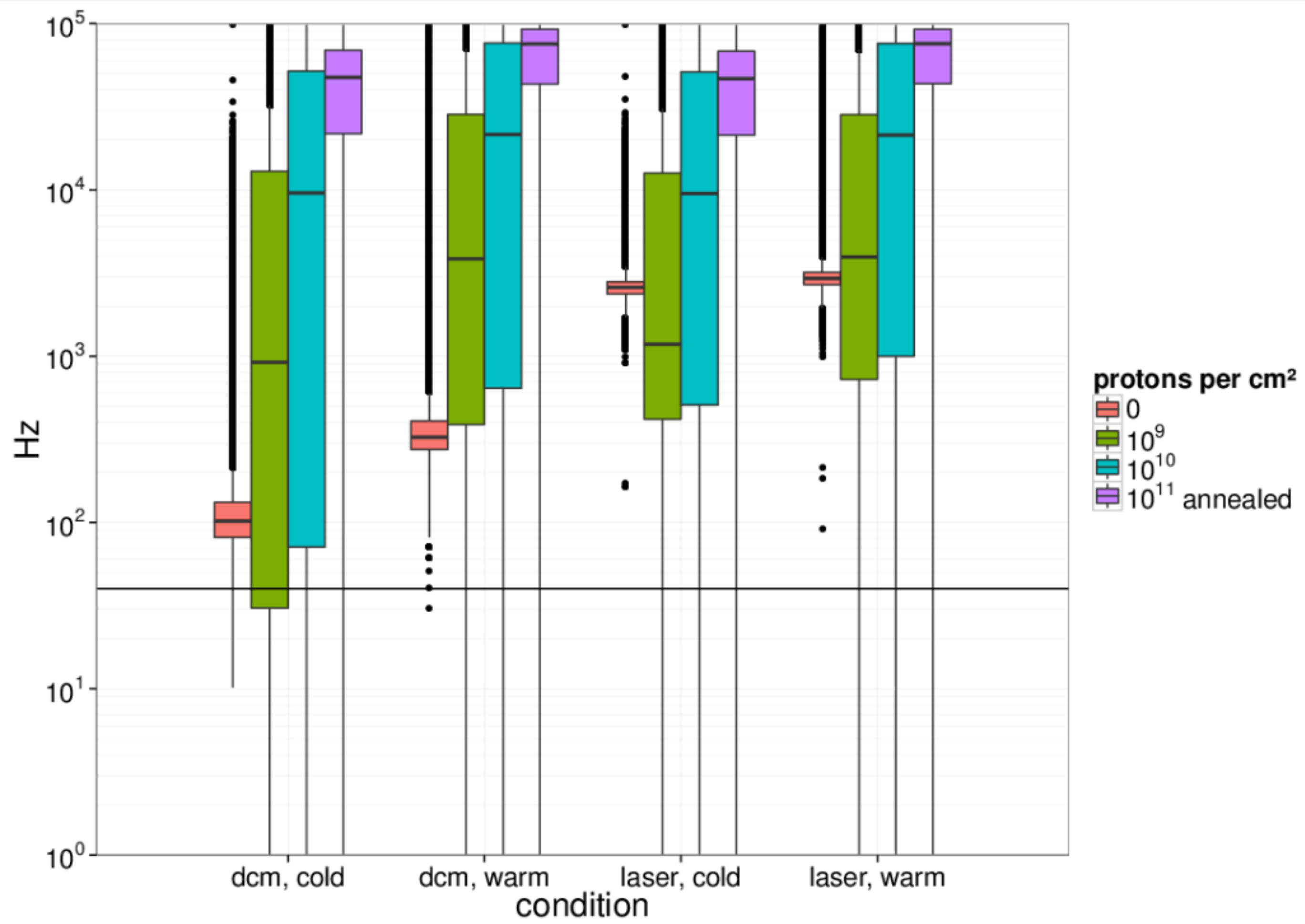


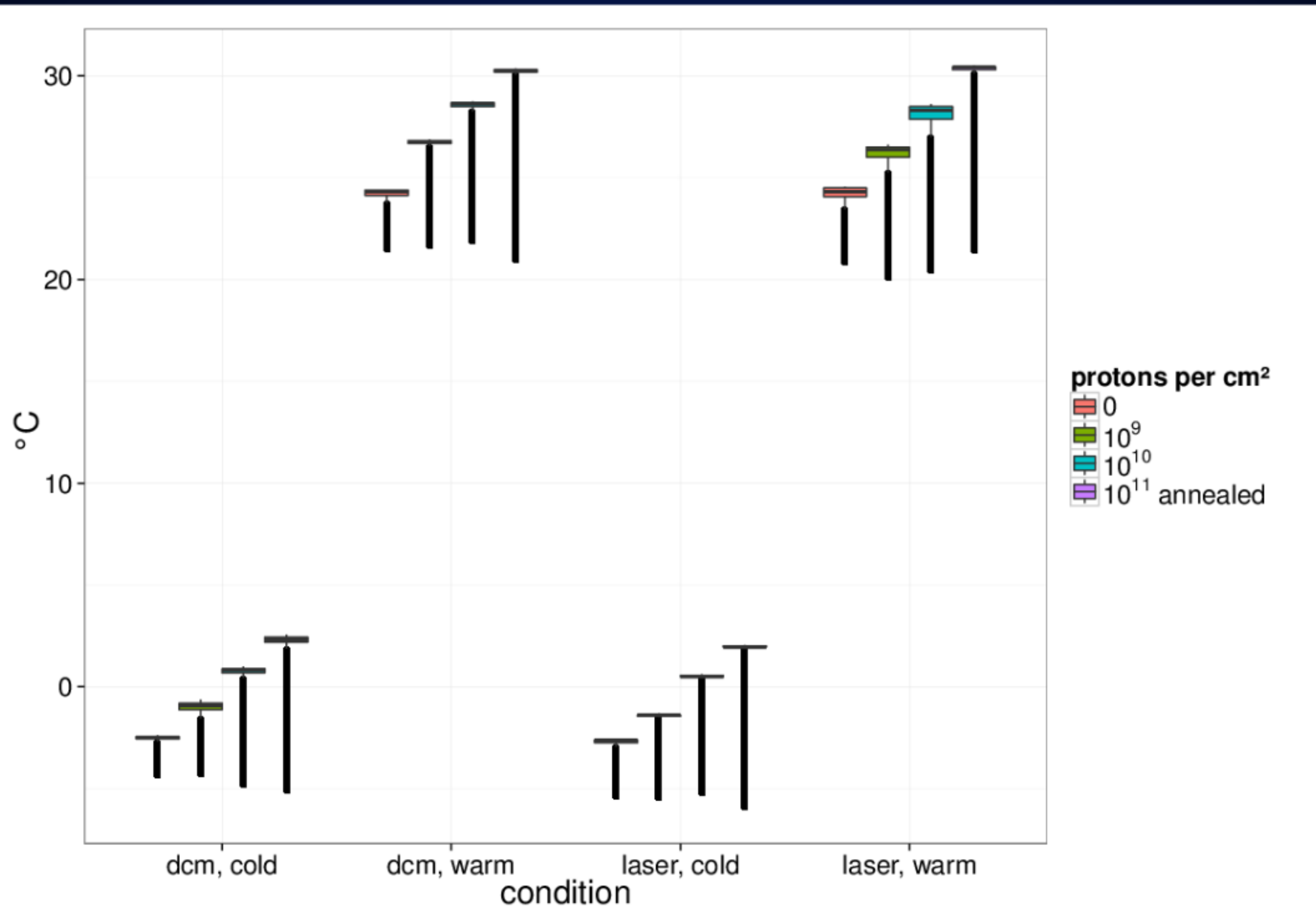
Rate and temperature distributions



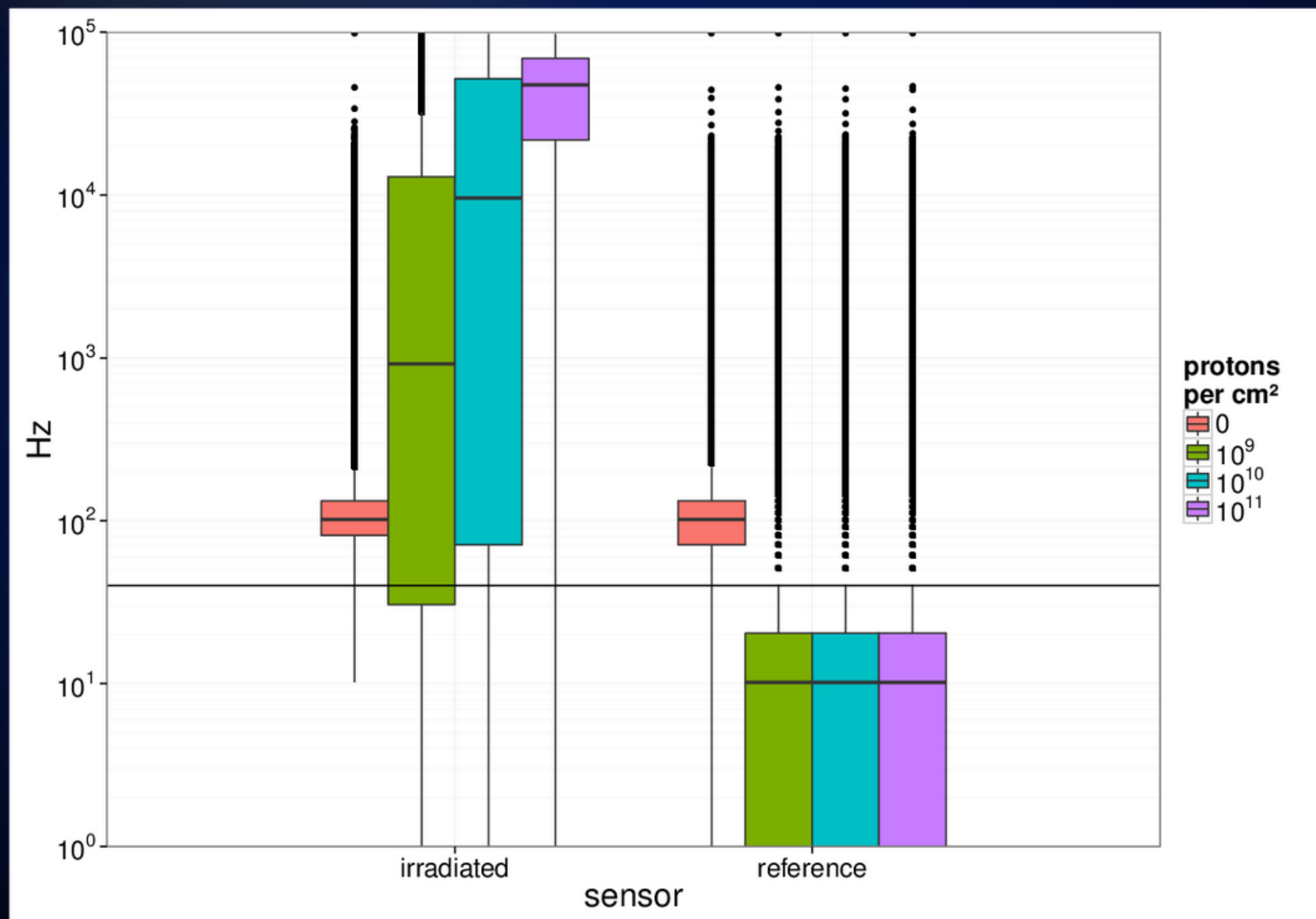




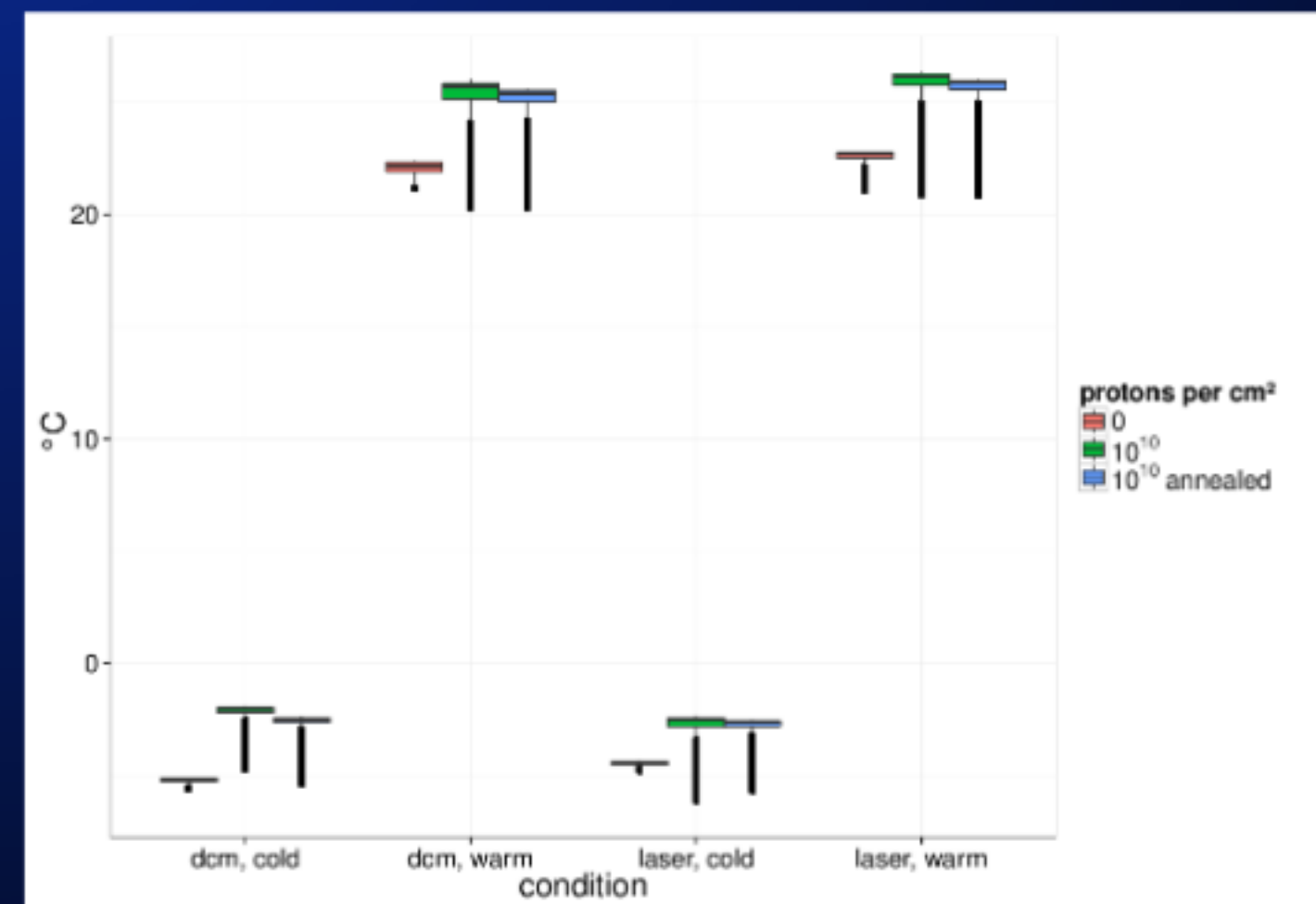
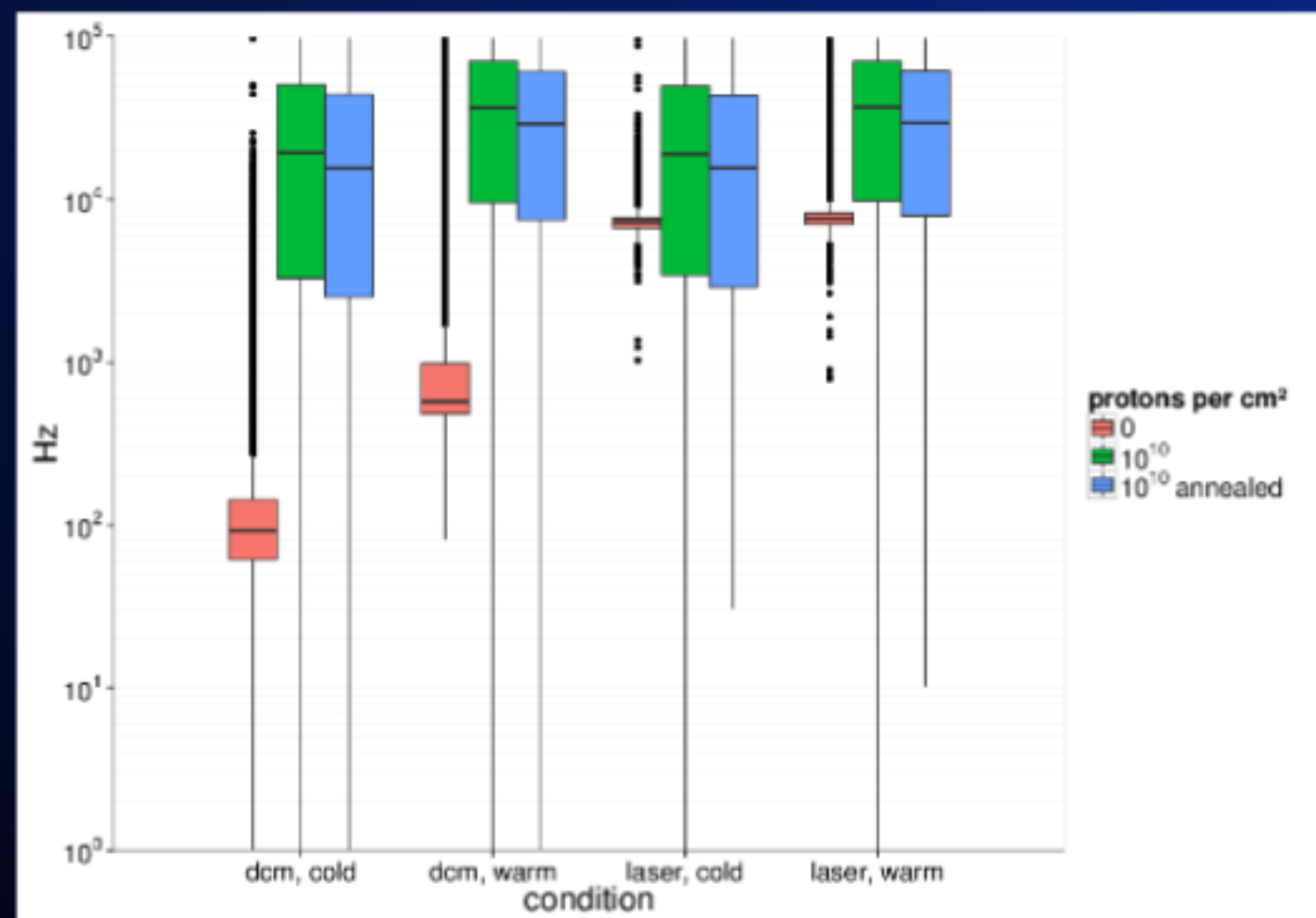
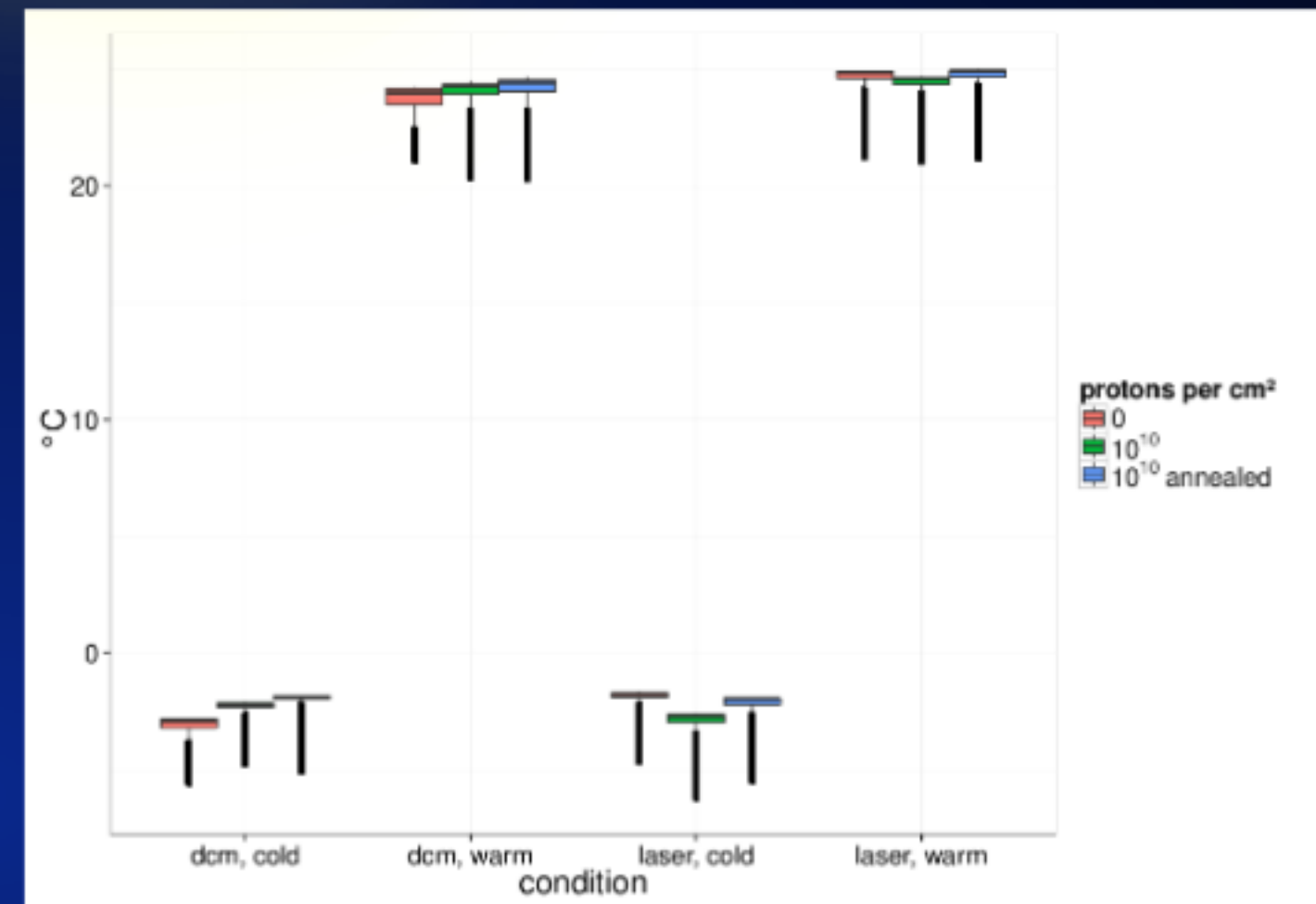
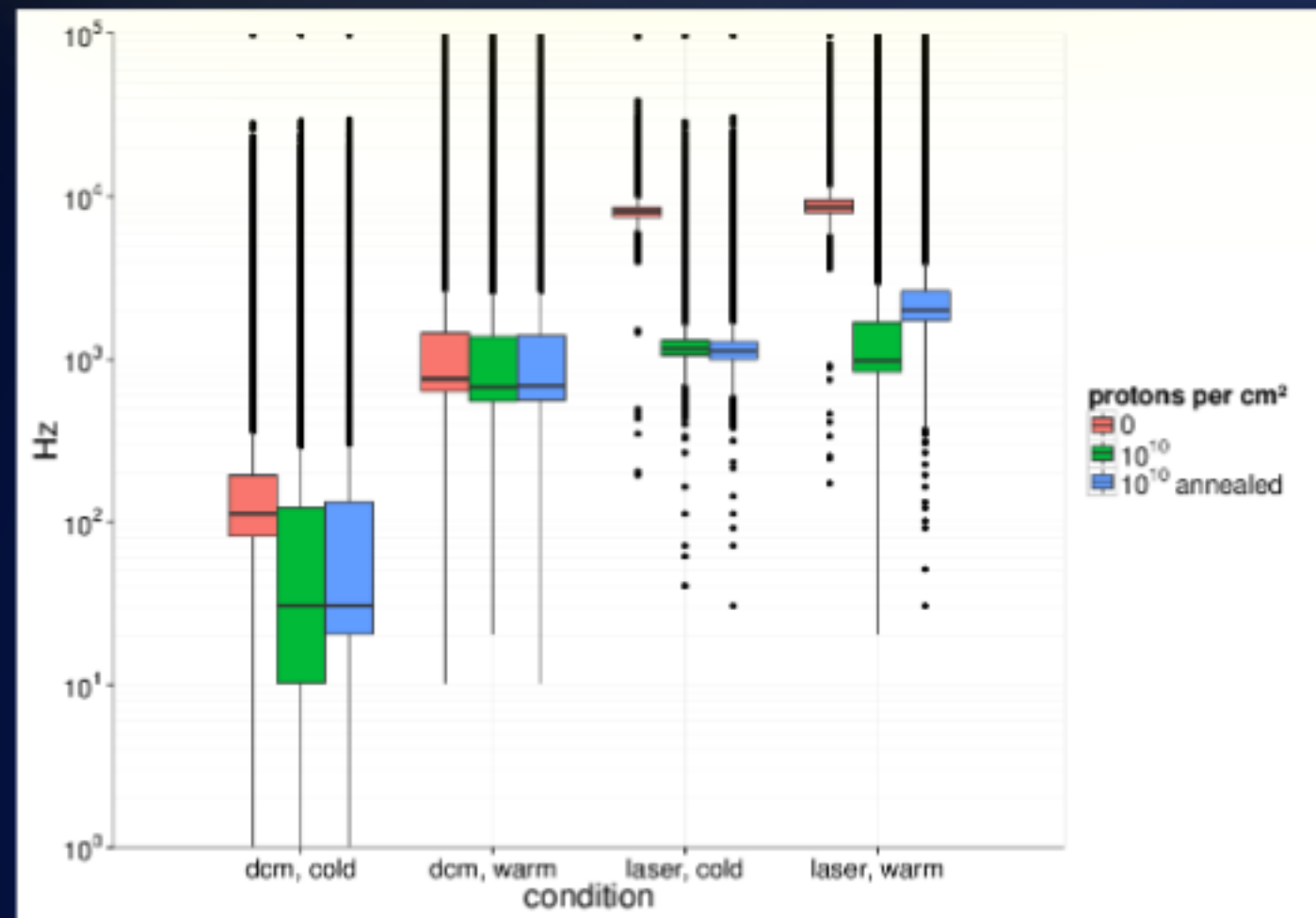


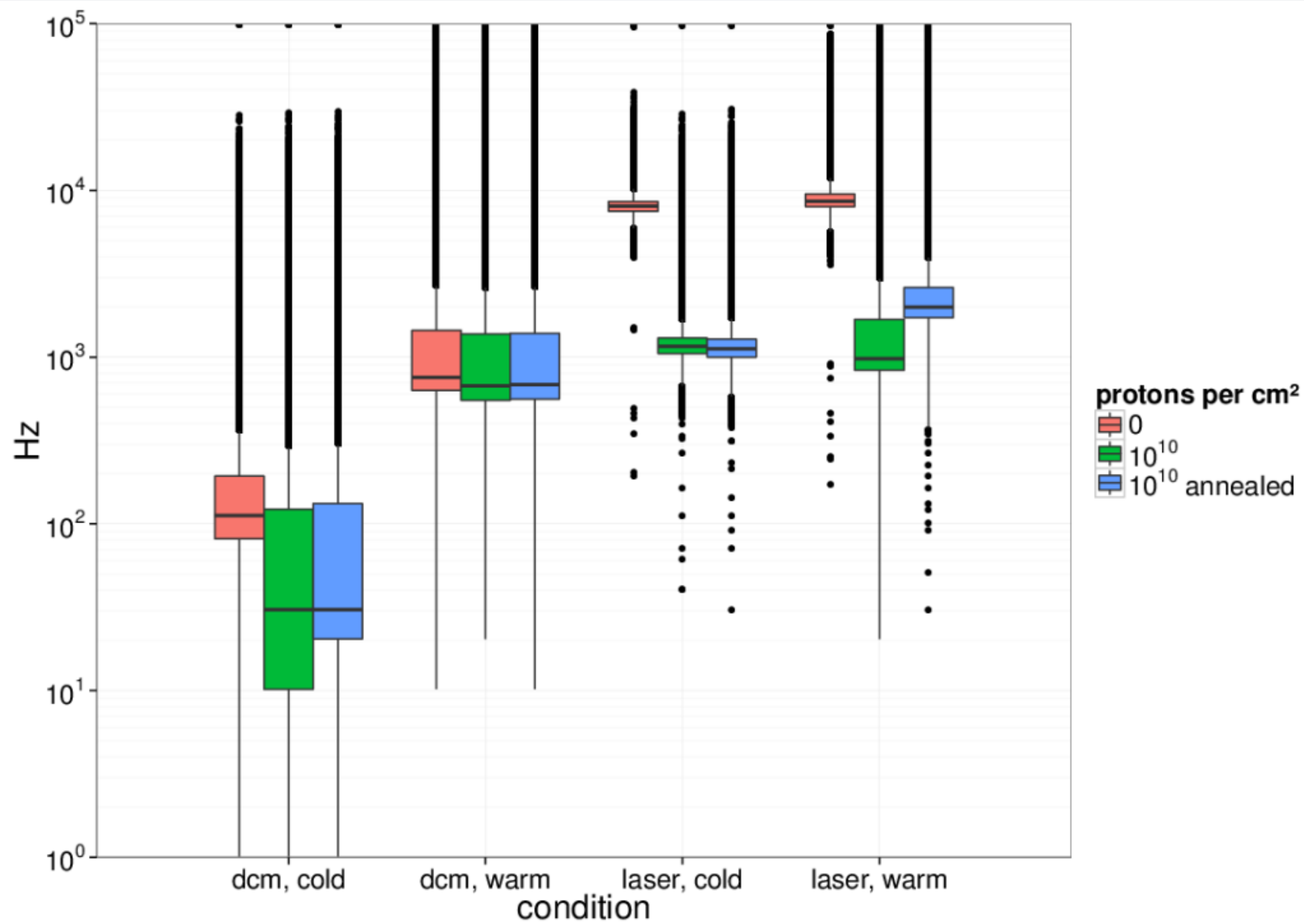


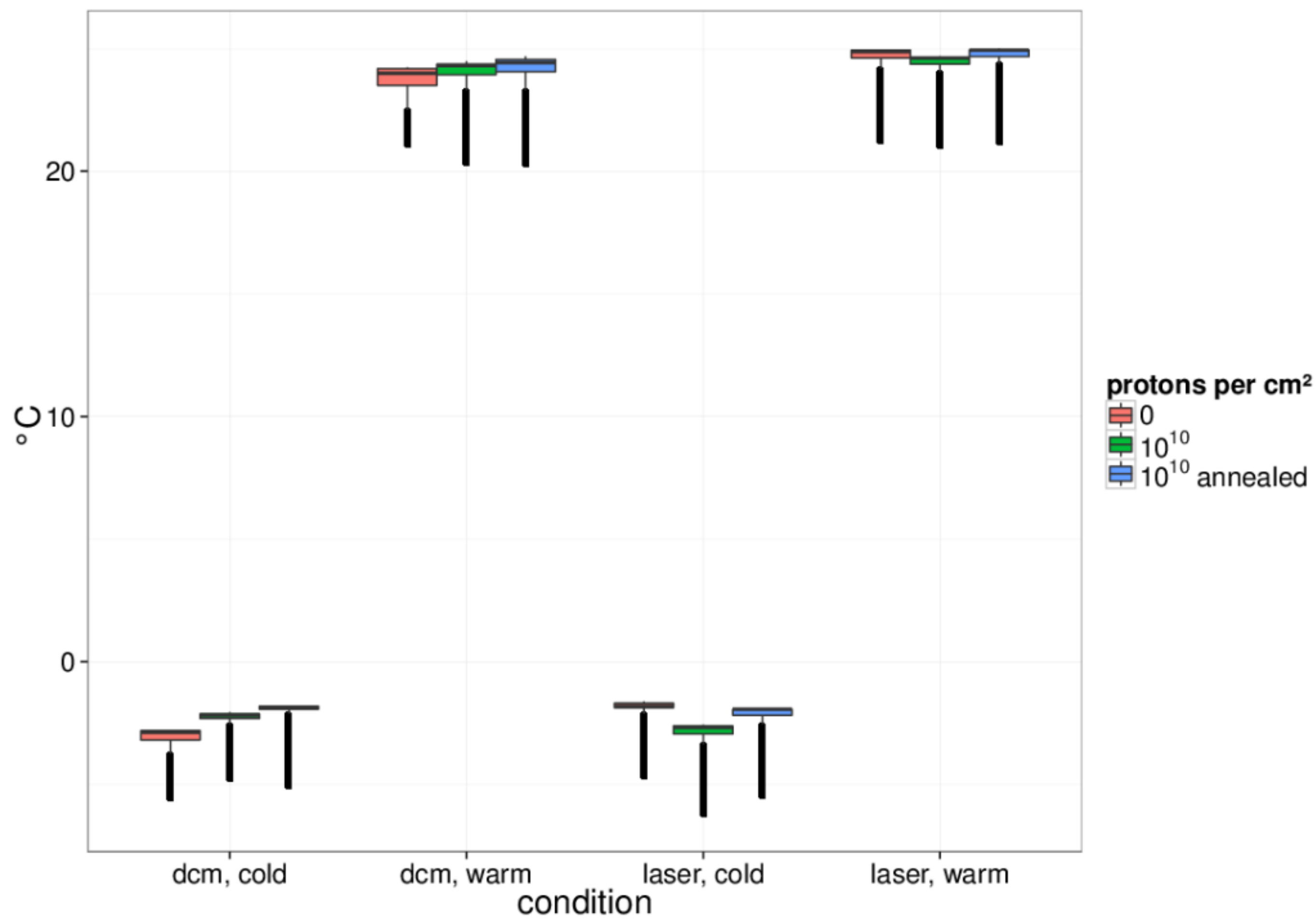
Comparison of the dark count measurements

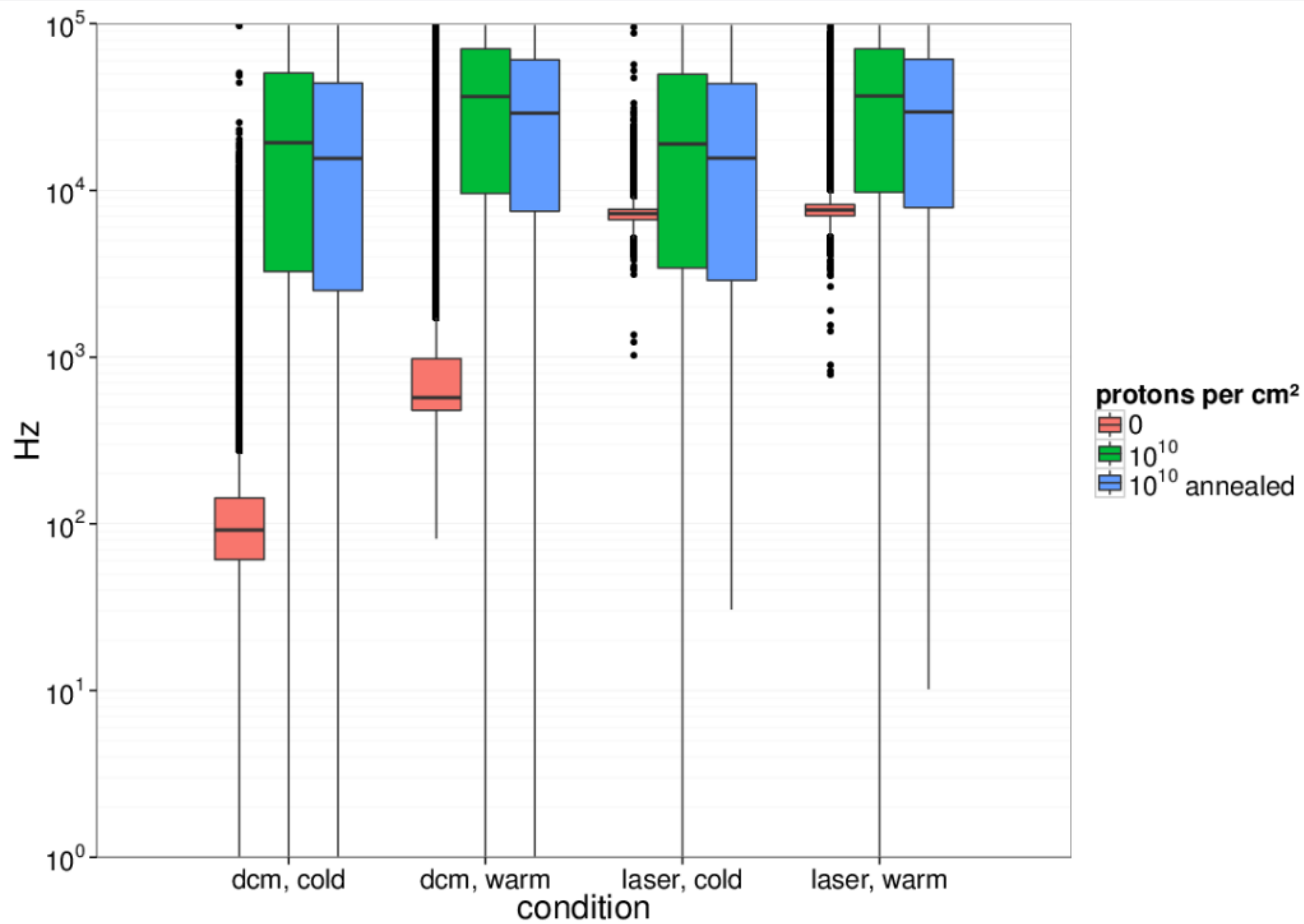


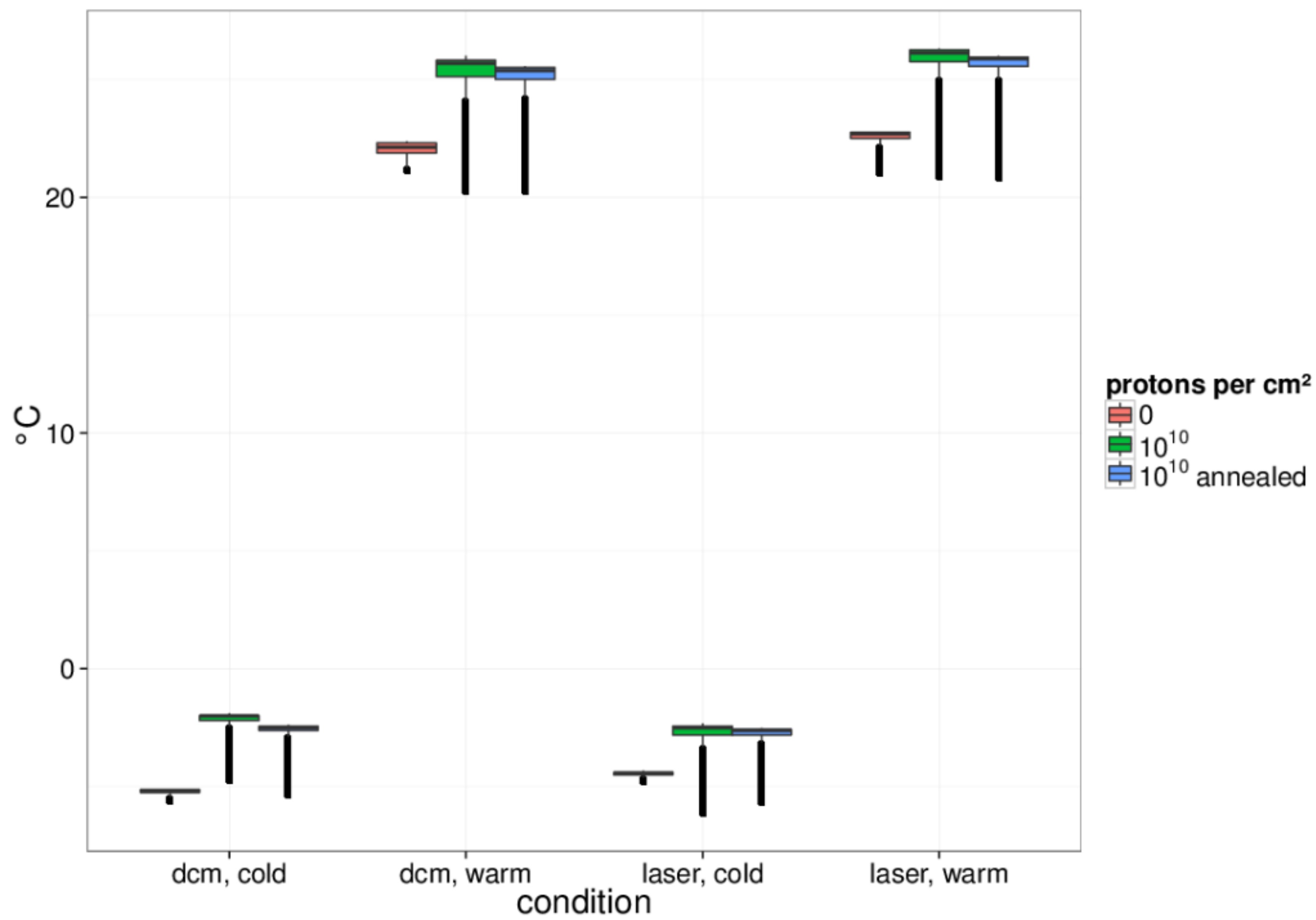
Annealing effect studies











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Interpretation of the radiation damage

Damage from defects in lattice or oxide charging?

- ▷ TEK module in stove at 80°C right now

Damage in SiPM cells or in electronics?

- ▷ Observed patterns ⇒ damage in electronics?
- ▷ Used transistors → ring transistors with guard ring
 - requires more space
 - fill factor decreases
 - PDE becomes worse
- ▷ Philips has already prototypes with radiation hard components.

Conclusion

- ▷ Dark count rate of TEK modules increases significantly after irradiation with protons.
- ▷ Cause of the damage is still analyzed.
- ▷ Currently available TEK modules are probably not suitable for PANDA.

Thanks to

- ▷ Dr. P.D.Eversheim (HISK Bonn)
- ▷ Operators from HISKP Bonn
- ▷ Thomas Frach (Philips)
- ▷ Ralf Schulze (Philips)